

PAN9028

Wi-Fi Dual Band 2.4 GHz/5 GHz and Bluetooth® Module

Product Specification

Rev. 1.1





Overview

The PAN9028 is a 2.4 GHz and 5 GHz ISM band Wi-Fi and Bluetooth radio module, which includes a wireless radio and a power management IC for easy integration of Wi-Fi and Bluetooth connectivity into various electronic devices.

Features

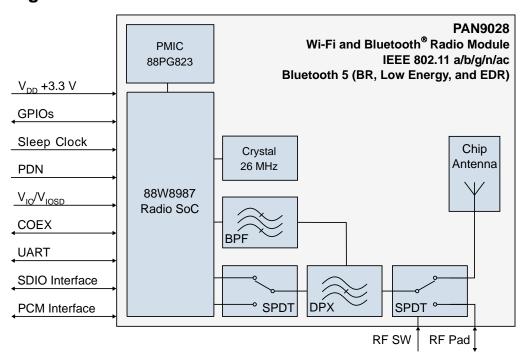
- Dual band 2.4 GHz and 5 GHz 802.11 a/b/g/n/ac Wi-Fi/Bluetooth combo module
- Supports 802.11i security standards through AES, CCMP, and more security mechanism
- 802.11e Quality of Service is supported for multimedia application
- IEEE 802.11ac (Wave 2), 1x1 spatial stream with data rates up to 433 Mbps (MCS9, 80 MHz channel bandwidth)
- IEEE 802.11ac MU-MIMO beamformee
- Bluetooth 5 (includes Low Energy)
- Dual simultaneous and independent WLAN and Bluetooth operation
- Dynamic Rapid Channel Switching (DRCS) for simultaneous operation in 2.4 GHz and 5 GHz bands
- Indoor location and navigation with IEEE 802.11mc

- Coexistence interface for arbitration of co-located WLAN, Bluetooth, or mobile wireless system (e.g. LTE or ZigBee®)
- Generic interfaces include SDIO 3.0 and high-speed UART for host processor connection
- Software driver Linux[®]

Characteristics

- Surface Mount Type (SMT)
 24 mm x 12 mm x 2.8 mm
- NXP[®] 88W8987 WLAN 2.4 GHz and 5 GHz and Bluetooth single-chip solution inside
- Single power supply: 3.3 V with Marvell® 88PG823 Power Management IC (optional)
- Tx power: 16 dBm at 802.11b
- Rx sensitivity: –97 dBm at 802.11b DSSS 1 Mbps
- IEEE 802.11ac 20 MHz, 40 MHz, 80 MHz channel bandwidth
- Long and Short Guard Interval support
- Current consumption Wi-Fi typical 320 mA (at Tx) and 70 mA (at Rx)
- SDIO 1 bit or 4 bit
- Wide temperature range of -30 °C to 85 °C

Block Diagram





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Information on Software

The PAN9028 module does not contain any software ex works, i.e. software is provided by 3rd party suppliers only. The essential software resources can be found on the partner website of NXP Semiconductors https://www.nxp.com/.

PIDEU provides a factory software programming service for your customized firmware; for further information please reach out to your local sales contact this regarding \Rightarrow 7.2.1 Contact Us.



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1 About This Document

1.1 Purpose and Audience

This Product Specification provides details on the functional, operational, and electrical characteristics of the Panasonic PAN9028 module. It is intended for hardware design, application, and Original Equipment Manufacturers (OEM) engineers. The product is referred to as "the PAN9028" or "the module" within this document. Unless otherwise stated the data in this document is valid for all module variants.

1.2 Revision History

Revision	Date	Modifications/Remarks	
0.1	2017-09-15	First preliminary version	
0.2	2020-08-28	New design. Added CPU frequencies, chapter "Restricted End Use", additional module and kit variants and versions, second module variant without PMIC and 32 kHz, module specific parameters, MR variant. Changed storage temperature.	
		Updated disclaimer, product overview, chapter "Overview", block diagram. Formal changes.	
1.0	2021-08-24	Updated picture "Block Diagram". Updated disclaimer. Updated features. Added regulatory chapter. Updated ordering information.	
1.1	2021-08-26	Changed regulatory chapter. Updated Layout	

1.3 Use of Symbols

Symbol	Description		
<u>(i)</u>	Note Indicates important information for the proper use of the product. Non-observance can lead to errors.		
<u> </u>	Attention Indicates important notes that, if not observed, can put the product's functionality at risk.		
⇒ [chapter number] [chapter title]	Cross reference Indicates cross references within the document. Example: Description of the symbols used in this document 1.3 Use of Symbols.		

1.4 Related Documents

For related documents please refer to the Panasonic website ⇒ 7.2.2 Product Information.

2 Overview

The PAN9028 is a dual band 2.4 GHz and 5 GHz 802.11 a/b/g/n/ac Wi-Fi radio module with integrated Bluetooth BR/EDR/Low Energy (LE), specifically designed for highly integrated and cost-effective applications. The simultaneous and independent operation of the two standards enables very high data rates (802.11ac) and low-power operation (Bluetooth LE). Integrated power management, a fast dual-core CPU, 802.11i security standard support, and high-speed data interfaces deliver the performance for the speed, reliability, and quality requirements of next generation products. Tx power calibration data, Wi-Fi, and Bluetooth system parameters are pre-stored on the one-time-programmable memory of the PAN9028 during production at Panasonic. This simplifies passing the certification process for PAN9028 customers. Furthermore, the module reduces design, test, and calibration effort resulting in reduced time-to-market compared to discrete solutions.

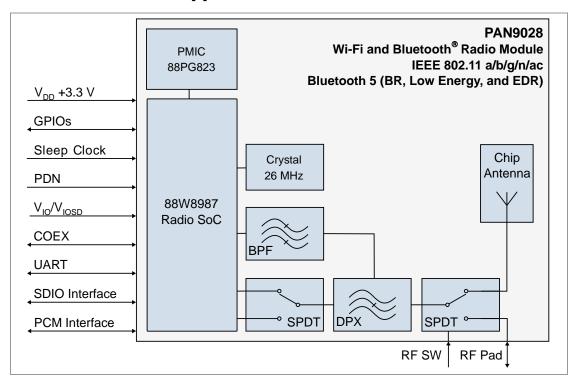
Integrating Wi-Fi and Bluetooth wireless connectivity allows high throughput applications for industrial devices and appliances. The combination of Wi-Fi and Bluetooth provides the highest flexibility for connectivity.

For related documents please refer to ⇒ 7.2.2 Product Information.

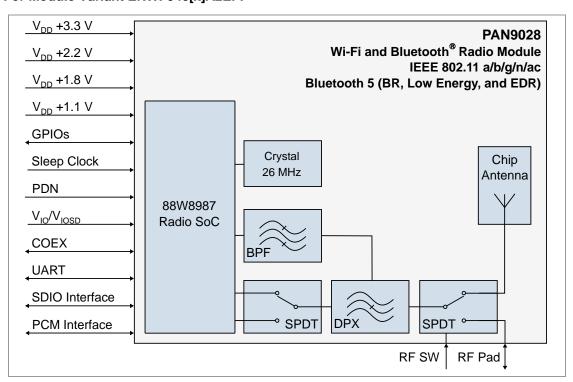
For further information on the variants and versions please refer to \Rightarrow 7.1 Ordering Information.

2.1 Block Diagram

For Module Variant ENWF940[x]A1EF:



For Module Variant ENWF940[x]A2EF:

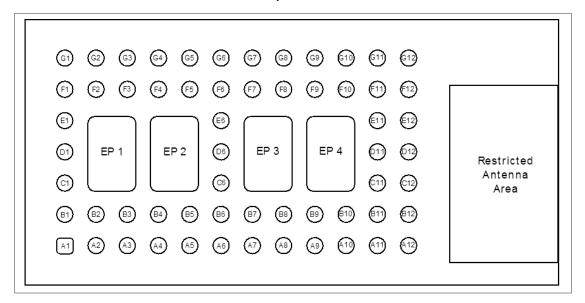




2.2 Pin Configuration

Pin Assignment

Top View



Pin Functions for Module Variant ENWF940[x]A1EF

No.	Pin Name	Pin Type	Description	
A1	GND	Ground pin	Connect to ground	
A2	PMIC_EN	Input signal	Power down of the PMIC, active-low	
A3	V _{OUT1V1}	Power	+1.1 V power supply output, only for internal supply	
A4	IO14 ³	Digital I/O	General Purpose I/O - GPIO [14]	
A5	DNC	NC	Do not connect	
A6 ¹	UART_CTS ²	Input signal	Clear-to-send input from peripheral device	
	IO10 ³	Digital I/O	General Purpose I/O – GPIO [10]	
A71	UART_RTS	Output signal	Request-to-send output to peripheral device	
	IO11 ³	Digital I/O	General Purpose I/O – GPIO [11]	
A8 ¹	UART_SIN	Input signal	Serial data input to peripheral device	
	IO9 ³	Digital I/O	General Purpose I/O – GPIO [9]	
A9	DNC	NC	Do not connect	

¹ Multi-purpose pins: After the firmware download, the pins (GPIO, Serial Interface, RF control) are programmed in functional mode with dedicated functionality.

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² UART mode: After the dedicated firmware download, the pin is used as Host Controller Interface (HCI) for Bluetooth.

 $^{^{\}rm 3}$ GPIO Mode: After the dedicated firmware download, the pin is used as Multi-Purpose Interface.

No.	Pin Name	Pin Type	Description	
A10	IO20 ³	Digital I/O	General Purpose I/O – GPIO [20]	
A11	RF_SW2	Input signal	RF Switch Pin 2 – logical voltage level to activate on-board antenna or RF Pad ⇔ RF-Switch Pin Function	
A12	GND	Ground pin	Connect to ground	
B1	PG1	Output signal	+1.1 V Power Good Output (float when not used)	
B2	IO1 ³	Digital I/O	General Purpose I/O – GPIO [1]	
В3	32KHZ_EN	Input signal	Disable internal 32.768 kHz crystal oscillator for LP modes (100 Ω to GND)	
B4	IO0 ³	Digital I/O	General Purpose I/O – GPIO [0]	
B5	DNC	NC	Do not connect	
B6 ¹	UART_DSR	Input signal	Data set ready from peripheral device	
	IO12 ³	Digital I/O	General Purpose I/O – GPIO [12]	
B7 ¹	UART_DTR	Output signal	Data terminal ready to peripheral device	
	IO13 ³	Digital I/O	General Purpose I/O – GPIO [13]	
B8 ^{1,4}	UART_SOUT	Output signal	Serial data output to peripheral device	
	IO8 ³	Digital I/O	General Purpose I/O – GPIO [8]	
В9	IO15 ³	Digital I/O	General Purpose I/O – GPIO [15]	
B10 ¹	COEX_OUT	Output signal	Serial data output to MWS modem or peripheral device	
	IO17 ³	Digital I/O	General Purpose I/O – GPIO [17]	
B11	RF_SW1	Input signal	RF Switch Pin 1 – logical voltage level to activate on-board antenna or RF Pad ⇒ RF-Switch Pin Function	
B12	GND	Ground pin	Connect to ground	
C1	PGLDO	Output signal	+1.8 V Power Good Output (float when not used) ⇒ 4.9 Power Good	
C6	CNTL2	Input signal	Connect this pin (with 50 k Ω to 100 k Ω) to GND	
C11	GND	Ground pin	Connect to ground	
C12	GND	Ground pin	Connect to ground	
D1	PG2	Output signal	+2.2 V Power Good Output (float when not used) ⇒ 4.9 Power Good	
D6	CNTL0	Input signal	Keep open (DNC) if using SDIO interface for Bluetooth or connect with 100 k Ω to GND if using UART interface for Bluteooth \Rightarrow Control Pin Function.	
D11	GND	Ground pin	Connect to ground	

⁴ Keep this pin open or on logical high level until firmware initialization or reset is finished. The definition of this pin changes immediately after firmware initialization or reset to its usual function.

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No.	Pin Name	Pin Type	Description	
D12	GND	Ground pin	Connect to ground	
E1 ¹	PCM_CLK	Input/Output	PCM clock signal, output if PCM master, input if PCM slave	
	IO6 ³	Digital I/O	General Purpose I/O – GPIO [6]	
E6	DNC	NC	Do not connect	
E11	GND	Ground pin	Connect to ground	
E12	GND	Ground pin	Connect to ground	
F1	GND	Ground pin	Connect to ground	
F2	V _{DD3V3}	Power	+3.3 V power supply connection	
F3	V _{DD3V3}	Power	+3.3 V power supply connection	
F4	V _{IOSD}	Power	+1.8 V or +3.3 V Digital I/O SDIO power supply	
F5 ¹	COEX_SIN	Input signal	Serial data input from MWS modem or peripheral device	
	IO16 ³	Digital I/O	General Purpose I/O – GPIO[16]	
F6 ¹	PCM_SYNC	Input/Output	PCM Sync Pulse signal, output if PCM master, input if PCM slave	
	IO7 ³	Digital I/O	General Purpose I/O – GPIO [7]	
F7 ¹	PCM_DOUT	Output signal	PCM data output signal	
	IO5 ³	Digital I/O	General Purpose I/O – GPIO [5]	
F8 ¹	LED_WLAN	Output pin	WLAN activity LED control	
	IO2 ³	Digital I/O	General Purpose I/O – GPIO [2]	
F9 ¹	LED_BT	Output pin	Bluetooth activity LED control	
	IO3 ³	Digital I/O	General Purpose I/O – GPIO [3]	
F10 ¹	PCM_DIN	Input signal	PCM data input signal	
	IO4 ³	Digital I/O	General Purpose I/O – GPIO [4]	
F11	GND	Ground pin	Connect to ground	
F12	GND	Ground pin	Connect to ground	
G1	V _{OUT2V2}	Power	+2.2 V power supply output, only for internal supply	
G2	V _{OUT2V2}	Power	+2.2 V power supply output, only for internal supply	
G3	V _{IO}	Power	+1.8 V or +3.3 V power supply for General Purpose I/O and UART	
G4	V _{OUT1V8}	Power	+1.8 V power supply output, only for internal supply	
G5	SD_CLK	Digital I/O	For SDIO specific terminals please refer to ⇒ SDIO Pin	
G6	SD_CMD	Digital I/O	Functions.	
G7	SD_DAT0	Digital I/O		
G8	SD_DAT1	Digital I/O		
G9	SD_DAT2	Digital I/O		

No.	Pin Name	Pin Type	Description
G10	SD_DAT3	Digital I/O	
G11	GND	Ground pin	Connect to ground
G12	RF_OUT	RF port	50Ω bottom pad to be activated by RF_SW1/RF_SW2 control voltage \Rightarrow RF-Switch Pin Function.
EP1	EPAD1	Thermal pin	Connect to ground
EP2	EPAD2	Thermal pin	Connect to ground
EP3	EPAD3	Thermal pin	Connect to ground
EP4	EPAD4	Thermal pin	Connect to ground



The V_{OUT1V1} , V_{OUT1V8} and V_{OUT2V2} power supply pins are only for internal purpose. Do not use them to power external curcuits.

Pin Functions for Module Variant ENWF940[x]A2EF

No.	Pin Name	Pin Type	Description	
A1	GND	Ground pin	Connect to ground	
A2	DNC	NC	Do not connect	
А3	V _{DD1V1}	Power	+1.1 V power supply connection	
A4	IO14 ³	Digital I/O	General Purpose I/O – GPIO [14]	
A5	DNC	NC	Do not connect	
A6 ¹	UART_CTS ²	Input signal	Clear-to-send input from peripheral device	
	IO10 ³	Digital I/O	General Purpose I/O – GPIO [10]	
A7 ¹	UART_RTS	Output signal	Request-to-send output to peripheral device	
	IO11 ³	Digital I/O	General Purpose I/O – GPIO [11]	
A8 ¹	UART_SIN	Input signal	Serial data input to peripheral device	
	IO9 ³	Digital I/O	General Purpose I/O – GPIO [9]	
A9	DNC	NC	Do not connect	
A10	IO20 ³	Digital I/O	General Purpose I/O – GPIO [20]	
A11	RF_SW2	Input signal	RF Switch Pin 2 – logical voltage level to activate on-board antenna or RF Pad ⇒ RF-Switch Pin Function.	
A12	GND	Ground pin	Connect to ground	
B1	DNC	NC	Do not connect	
B2	IO1 ³	Digital I/O	General Purpose I/O – GPIO [1]	
В3	DNC	NC	Do not connect	

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No.	Pin Name	Pin Type	Description	
B4	IO0 ³	Digital I/O	General Purpose I/O – GPIO [0]	
B5	PDn	Input signal	Power Down. Low active	
B6 ¹	UART_DSR	Input signal	Data set ready from peripheral device	
	IO12 ³	Digital I/O	General Purpose I/O – GPIO [12]	
B7 ¹	UART_DTR	Output signal	Data terminal ready to peripheral device	
	IO13 ³	Digital I/O	General Purpose I/O – GPIO [13]	
B8 ^{1,4}	UART_SOUT	Output signal	Serial data output to peripheral device	
	IO8 ³	Digital I/O	General Purpose I/O – GPIO [8]	
B9 ¹	IO15 ³	Digital I/O	General Purpose I/O – GPIO [15]	
B10 ¹	COEX_OUT	Output signal	Serial data output to MWS modem or peripheral device	
	IO17 ³	Digital I/O	General Purpose I/O – GPIO [17]	
B11	RF_SW1	Input signal	RF Switch Pin 1 – logical voltage level to activate on-board antenna or RF Pad ⇔ RF-Switch Pin Function.	
B12	GND	Ground pin	Connect to ground	
C1	DNC	NC	Do not connect	
C6	CNTL2	Input signal	Connect this pin (with 50 k Ω to 100 k Ω) to GND	
C11	GND	Ground pin	Connect to ground	
C12	GND	Ground pin	Connect to ground	
D1	DNC	NC	Do not connect	
D6	CNTL0	Input signal	Keep open (DNC) if using SDIO interface for Bluetooth or connect with 100 kΩ to GND if using UART interface for Bluetooth ⇒ Control Pin Function.	
D11	GND	Ground pin	Connect to ground	
D12	GND	Ground pin	Connect to ground	
E1 ¹	PCM_CLK	Input/Output	PCM clock signal, output if PCM master, input if PCM slave	
	IO6 ³	Digital I/O	General Purpose I/O – GPIO [6]	
E6	DNC	NC	Do not connect	
E11	GND	Ground pin	Connect to ground	
E12	GND	Ground pin	Connect to ground	
F1	GND	Ground pin	Connect to ground	
F2	V _{DD3V3}	Power	+3.3 V power supply connection	
F3	V _{DD3V3}	Power	+3.3 V power supply connection	
F4	V _{IOSD}	Power	+1.8 V or +3.3 V Digital I/O SDIO power supply	
F5 ¹	COEX_SIN	Input signal	Serial data input from MWS modem or peripheral device	

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2 Overview

No.	Pin Name	Pin Type	Description	
	IO16 ³	Digital I/O	General Purpose I/O – GPIO [16]	
F6 ¹	PCM_SYNC	Input/Output	PCM Sync Pulse signal, output if PCM master, input if PCM slave	
	IO7 ³	Digital I/O	General Purpose I/O – GPIO [7]	
F7¹	PCM_DOUT	Output signal	PCM data output signal	
	IO5 ³	Digital I/O	General Purpose I/O – GPIO [5]	
F8 ¹	LED_WLAN	Output pin	WLAN activity LED control	
	IO2 ³	Digital I/O	General Purpose IO – GPIO [2]	
F9 ¹	LED_BT	Output pin	Bluetooth activity LED control	
	IO3 ³	Digital I/O	General Purpose I/O – GPIO [3]	
F10 ¹	PCM_DIN	Input signal	PCM data input signal	
	IO4 ³	Digital I/O	General Purpose I/O – GPIO [4]	
F11	GND	Ground pin	Connect to ground	
F12	GND	Ground pin	Connect to ground	
G1	V _{DD2V2}	Power	+2.2 V power supply connection	
G2	V _{DD2V2}	Power	+2.2 V power supply connection	
G3	V _{IO}	Power	+1.8 V or +3.3 V power supply for General Purpose I/O and UART	
G4	V _{DD1V8}	Power	+1.8 V power supply connection	
G5	SD_CLK	Digital I/O	For SDIO specific terminals please refer to ⇒ SDIO Pin	
G6	SD_CMD	Digital I/O	Functions.	
G7	SD_DAT0	Digital I/O		
G8	SD_DAT1	Digital I/O		
G9	SD_DAT2	Digital I/O		
G10	SD_DAT3	Digital I/O		
G11	GND	Ground pin	Connect to ground	
G12	RF_OUT	RF port	50 Ω bottom pad to be activated by RF_SW1/RF_SW2 control voltage \Rightarrow RF-Switch Pin Function.	
EP1	EPAD1	Thermal pin	Connect to ground	
EP2	EPAD2	Thermal pin	Connect to ground	
EP3	EPAD3	Thermal pin	Connect to ground	
EP4	EPAD4	Thermal pin	Connect to ground	



SDIO Pin Functions for all Module Variants

No.	Pin Name	Pin Type	Description	
			4-Bit Mode	1-Bit Mode
G5	SD_CLK	Digital I/O	Clock	Clock
G6	SD_CMD	Digital I/O	Command Line	Command Line
G7	SD_DAT0	Digital I/O	Data Line bit [0]	Data Line
G8	SD_DAT1	Digital I/O	Data Line bit [1] or Interrupt (optional)	Interrupt
G9	SD_DAT2	Digital I/O	Data Line bit [2] or Read Wait (optional)	Read Wait (optional)
G10	SD_DAT3	Digital I/O	Data Line bit [3]	Not used

RF-Switch Pin Functions for all Module Variants

No.	Pin Name	Pin Type	Logical Level for Activation			Logical Level for Activation		
			On-Board Chip Antenna	RF OUT Pin				
B11	RF_SW1	Input signal	GND (0 V)	3.0 V to 3.6 V (typ. 3.3 V)				
A11	RF_SW2	Input signal	3.0 V to 3.6 V (typ. 3.3 V)	GND (0 V)				

Control Pin Function for all Module Variants

The control pin is used as configuration input to set parameters following a reset. The definition of the pin changes immediately after a reset to its usual function. To set a configuration bit to "02, attach a $50 \text{ k}\Omega$ to $100 \text{ k}\Omega$ resistor from the pin to ground. No external circuitry is required to set a configuration bit to "1".



The configuration of the control pin is used for the firmware boot option. The software reads and boots accordingly.

No.	Pin	Pin Type	Strap	WLAN	AN Bluetooth/ Bluetooth LE	Firmware Download		Number SDIO
	Name		Value			Туре	Mode	Functions
D6	D6 CNTL0 Input Signal	0	SDIO	UART	SDIO+UART	Parallel/Serial	1 (WLAN)	
			1	SDIO	SDIO	SDIO+SDIO	Parallel/Serial	2 (WLAN, Bluetooth)



2.3 Host Interface

The bus interface connects several host interface bus units to the CPU bus of the device through the internal bus. The connection of each unit is multiplexed with other bus units.

The high-speed UART interface is connected to the CPU bus through a separate bus.

Туре	Features
High-speed UART interface	The device supports a high-speed Universal Asynchronous Receiver/Transmitter (UART) interface, compliant with the industry standard 16550 specification.
	 FIFO mode permanently selected for transmit and receive operations Two pins for transmit and receive operations Two flow control pins Interrupt triggers for low-power, high throughput operation
SDIO interface	The device supports an SDIO device interface that conforms to the industry standard SDIO full-speed card specification and allows a host controller using the SDIO bus protocol to access the device.
	Supports SDIO 3.0 Standard
	1-bit SDIO or 4-bit SDIO transfer modes with full clock range up to 208 MHz
	On-chip memory used for CIS
	Special interrupt register for information exchange
	Allows card to interrupt host

For further information please refer to ⇒ 4.10.1 Host Interface.

2.4 Peripheral Bus Interfaces

The Peripheral Bus Unit (PBU) connects several low speed peripherals to the internal bus of the device. The device consists of the GPIO Interface and the One Time Programmable Memory (OTP).

Туре	Features
General Purpose I/O (GPIO) Interface	 User-defined GPIOs (each configured to either input or output) Each GPIO controlled independently Each I/O configurable to output bit from GPIO_OUT
One Time Programmable Memory (OTP)	 Storing device-specific calibration data and hardware information like MAC/BD address, WLAN, and Bluetooth parameters Programmed during production process of device Device performs calibration when it is powered up

For further information please refer to ⇒ 4.10.2 Peripheral Interface.

2.5 PCM Interfaces

The device supports the PCM interface.

Туре	Features	
PCM Interface	 Master or slave mode PCM bit width size of 8 bits or 16 bits 	
	Up to four slots with configurable bit width and start positions	
	Short frame and long frame synchronization	

For further information please refer to ⇒ 4.10.3 Audio Interface.

2.6 Coexistence

The implemented coexistence framework is based on the IEEE 802.15.2 recommended practice Packet Traffic Arbitration (PTA) scheme and the Bluetooth Special Interest Group (Bluetooth) Core Specification Volume 7 (Wireless Coexistence Volume).

2.6.1 WLAN and Bluetooth Channel Information Exchange

Since Bluetooth and IEEE 802.11b/g/n WLAN use the same 2.4 GHz frequency band, each can cause interference with the other. The level of interference depends on the respective frequency channel used by Bluetooth and WLAN (other factors can impact interference, like Tx power and Rx sensitivity of the device).

In a system with both Bluetooth and WLAN, the common host receives information about WLAN channel usage and passes the information to the Bluetooth device. For Bluetooth 1.2 devices with Adaptive Frequency Hopping (AFH) enabled, the Bluetooth device can block channel usage that overlaps the WLAN channel in use.

When the Bluetooth device avoids all channels used by the WLAN, the impact of interference is reduced, but not completely eliminated. For Bluetooth 1.1 devices, the Bluetooth device cannot block WLAN channel usage. In this case, a Bluetooth Coexistence Arbiter (BCA) scheme at MAC level is required. The BCA scheme can also be used with Bluetooth 1.2 devices to further reduce the impact of interference to a minimum.

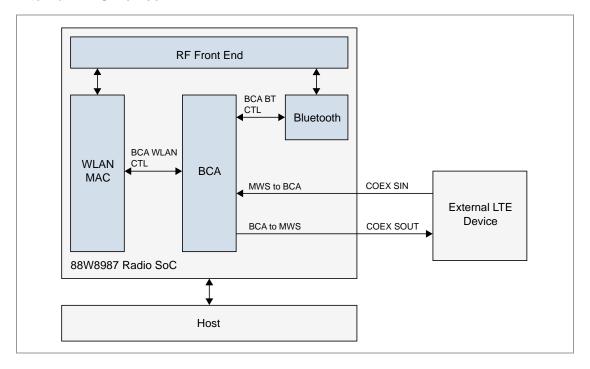
2.6.2 External Mobile Wireless System (LTE or ZigBee) and BCA Exchange

Based on the Bluetooth SIG Wireless Coexistence Volume, the device supports a Wireless Coexistence Interface 2 (WCI-2) protocol for WLAN/Bluetooth coexistence with an external Mobile Wireless System (MWS), such as a Long Term Evolution (LTE) or ZigBee device. WCI-2 is a 2-wire transport interface. An internal coexistence is used to exchange request/grant with the BCA.



2.6.3 System Configuration

External MWS Device



2.6.4 WCI-2 Interface

The coexistence interface includes a Mobile Wireless System (MWS) transport controller to accommodate a 2-wire, UART-based serial transport interface. This interface is a standard full-duplex UART (TxD and RxD) carrying logical signals framed as UART characters. In addition, it allows support of multiple logical channels.

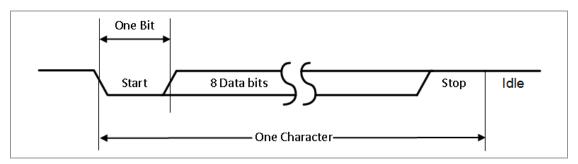
Interface Signals

Pin No.	Signal Name	Specification Name	Pin Type	Description
F5	COEX_SIN	RxD	Input	Serial data from external MWS device
B10	COEX_SOUT	TxD	Output	Serial data to external MWS device



Signal Waveform Format

The messaging is based on a standard UART format. The UART signals should be connected like a null-modem. For example, the local TxD connected to the remote RxD and vice versa.



Interface Transport Settings

Item	Range	Comment
Baudrate	921 600 ~ 4 000 000	Baud
Data Bits	8	LSB first
Parity Bits	0	No parity
Stop Bit	1	One stop bit
Flow Control	No	No flow control

Support Baud Rates

Baud			
921 600	2 000 000	3 000 000	4 000 000

Real-Time Signaling Message

The real-time signaling message is used to transport real-time signals over the 2-wire transport interface.

The real-time signaling message conveys the real-time signals (Bluetooth Core Specification, Volume 7, Part A) in one message. The time reference point for the real-time signaling message is the end of message bit 5 (transition to stop bit).

Defined real-time signaling messages include:

- Coexistence Controller to MWS device
- MWS device to Coexistence Controller

Real-Time Signaling	MSG [0]	MSG [1]	MSG [2]	MSG [3]	MSG [4]
MWS to Coexistence Controller (Signal)	FRAME_SYNC	MWS_RX	MWS_TX	PATTERN [0]	PATTERN [1]
Coexistence Controller to MWS (Message)	BLUETOOTH _RX_PRI	BLUETOOTH _TX_ON	802_RX_PRI	802_TX_ON	RFU

Signal Name
FRAME_SYNC
MWS_RX
MWS_TX
PATTERN [1, 0]
BT_RX_PRI
BT_TX_ON
802_RX_PRI
802_TX_ON
MWS_INACTIVITY_DURATION
MWS_SCAN_FREQUENCY_OFFSET

Transport Control Message

The transport control messages can modify the state and request state information of the MWS coexistence interface.

Message	MSG [0]	MSG [1]	MSG [2]	MSG [3]	MSG [4]
Transport Control Message	RESEND_REAL _TIME	RFU	RFU	RFU	RFU

Signal Name	Description
RESEND_REAL_TIME	This bit is set if a device wants to get a status update of the real-time signals. The signal is usually used after wake-up from sleep of the transport interface to get an update of the real-time signals.
	If the receiving device's transport interface is awake it shall send a real-time message with the current status of the real-time signals within 4 UART character period. If the signal is not transmitted within 4 UART character periods, the device is considered asleep.
	If the receiving device's transport interface is not awake it shall not send a real-time message.
	Bluetooth initiated: If the MWS is currently scanning or has an ongoing inactivity duration, the MWS shall send a frequency scan message or an inactivity duration message after transmitting the real-time message. If the receiving device's transport interface is not awake it shall not send a frequency scan or inactivity duration message.



Transparent Data Message

The transparent control messages can modify the state and request state information of the MWS coexistence interface.

Message	MSG [0]	MSG [1]	MSG [2]	MSG [3]	MSG [4]
Transparent Data Message	NIBBLE_POSIT	DATA [0]/[4]	DATA [1]/[5]	DATA [2]/[6]	DATA [3]/[7]

Signal Name	Description	
NIBBLE_POSITION	0 = least significant nibble	
	1 = most significant nibble	
DATA[n]; n=0 7	Data bits of the message octet	

MWS Inactivity Duration Message

The inactivity duration messages is used to send the MWS_INACTIVITY_DURATION signal from the MWS device to the Coexistence Controller.

Message	MSG [0]	MSG [1]	MSG [2]	MSG [3]	MSG [4]
MWS Inactivity Duration Message	DURATION [0]	DURATION [1]	DURATION [2]	DURATION [3]	DURATION [4]

The idle duration is encoded in 5 bits given by the formula:

Inactivity_Duartion = DURATION \cdot 5 ms

Inactivity durarations smaller than 5 ms are not communicated.

If all bits are set to "1" the inactivity duration is infinite. If all bits are set to "0" or MWS_RX or MWS_TX are set to "1", the inactivity period ends.

MWS Scan Frequency Offset Message

The MWS scan frequency offset message is used to send the MWS_SCAN_FREQUENCY_ OFFSET signal from the MWS device to the Coexistence Controller.

Message	MSG [0]	MSG [1]	MSG [2]	MSG [3]	MSG [4]
MWS Scan Frequency Offset	BAND	FREQ [0]	FREQ [1]	FREQ [2]	FREQ [3]

The RF scan frequency is encoded in 5 bits given by the formula:

$$\mathsf{RF_FREQ_OFFSET} = \mathsf{FREQ} \cdot 10\,\mathsf{MHz}$$

If BAND is set to "0" the RF_FREQ_OFFSET is the negative value from the lower edge of the ISM band and if BAND is set to "1", RF_FREQ_OFFSET is the positive value from the top edge of the ISM band.

FREQ set to all "0" indicates the end of the scan period.

2 Overview

Panasonic



Bluetooth Coexistence Arbiter 2.6.5

Туре	Features
Capability	 Programmable coexistence interface timing, interface modes, and signal polarity to support a variety of external Bluetooth devices Programmable decision policies and transaction lock behavior for various use cases Interface with external or on-chip Bluetooth device Support Bluetooth 1.1 or Bluetooth 1.2 AFH WLAN-/Bluetooth-coordinated low-power design Enhanced information sharing between WLAN and Bluetooth for combo systems WLAN/Bluetooth/MWS (LTE or ZigBee) coexistence support
Arbitration	 Contention resolved by a customizable decision matrix that allows independent grant decision for each device Vectors for the decision matrix: WLAN priority (2-bit) WLAN direction Bluetooth priority (1-bit or 2-bit) Bluetooth direction Bluetooth frequency in/out band MWS priority (2-bit) MWS direction
AFH	If AFH is enabled in the Bluetooth device, and there is a sufficient guard-band outside the WLAN operating frequency, the Bluetooth device uses the Out-Of-Band (OOB) channel with respect to the WLAN device. Otherwise, the Bluetooth device uses the In-Band (IB) and OOB channels with respect to the WLAN device. The IB and OOB information is either provided by the Bluetooth device through the coexistence interface, or it can be provided through firmware controls in a shared-host system. IB/OOB is a vector in the decision matrix.
Decision Policies	System configuration is a major consideration when planning decision policies. The configuration governs how RF paths are shared and how much interference will occur. Interference combinations include: - WLAN Tx and Bluetooth Tx - WLAN Tx and Bluetooth Rx - WLAN Rx and Bluetooth Tx - WLAN Rx and Bluetooth Rx Interference combinations where WLAN and Bluetooth share the same antenna: - WLAN Tx and Bluetooth Tx share same antenna, the decision matrix allows either WLAN or Bluetooth Tx (both OOB and IB), based on relative packet priorities. - WLAN Tx and Bluetooth Rx (both OOB and IB) have sizable interference impacts on Bluetooth Rx, the decision matrix grants or denies WLAN Tx based on relative packet priorities. - WLAN Rx and Bluetooth Tx (both OOB and IB) have sizable interference impacts on WLAN Rx and Bluetooth Tx (both OOB and IB) have sizable interference impacts on WLAN Rx, the decision matrix grants or denies Bluetooth Tx based on relative
	 packet priorities. WLAN Rx and Bluetooth Rx (both OOB and IB) have no impact on each other, the decision matrix grants both.

Туре	Features
	Interference combinations where WLAN and Bluetooth have their own antenna:
	 WLAN Tx and Bluetooth Tx in OOB situation have little interference impact on each other, the decision matrix grants both. WLAN Tx and Bluetooth Tx in IB have sizable interference impact on each other, the decision matrix allows either WLAN or Bluetooth Tx, based on relative packet priorities. WLAN Tx and Bluetooth Rx in OOB situation have little interference impact on each other, the decision matrix grants both provided there is enough antenna isolation between WLAN and Bluetooth antenna. WLAN Tx and Bluetooth Rx in IB situation have sizable interference impact on Bluetooth Rx, the decision matrix grants or denies WLAN Tx based on relative packet priorities. WLAN Rx and Bluetooth Tx in OOB situation have little interference impact on each other, the decision matrix grants both provided there is enough antenna isolation between WLAN and Bluetooth antenna. WLAN Rx and Bluetooth Tx in IB situation have sizable interference impact on WLAN RX, the decision matrix grants or denies Bluetooth Tx based on relative packet priorities. WLAN Rx and Bluetooth Rx (both OOB and IB) have no impact on each other, the decision matrix grants both.
Decision Policies (continued)	For the devices running in a basic shared antenna configuration, the linear switching imposes restrictions on simultaneous transfer. Reasonable policies include: - WLAN and Bluetooth are never granted at the same time - Decision matrix grants a device based on relative packet priorities and direction - Priority order: High > Medium High > Medium > Low - For equal priority contention, select one device to win, that optimizes the usage case For the devices running in an enhanced shared antenna configuration, the linear switching imposes restrictions on some simultaneous transfers.
Transaction Stopping	The arbiter allows control of what transfers can be stopped after an initial grant. If allowed, a transaction can be stopped for higher priority request. A transaction stop decision is a function of the decision policies and transaction stopping control. The transaction stopping control is configurable per device and direction.



2.6.6 Bluetooth Capability

Туре	Features
Request Schemes	The PTA signals are directly controlled by the hardware to meet timing requirements of the Bluetooth radio. The software controls the type of traffic in priority mode.
	Mechanisms enforced for control include:
	Selection of certain types of communication always treated as high priority
	Selection of individual frames marked with high priority
	Real-time signaling of the next slot marked with high priority
	Automatic hardware control based on the grant/denial history of the Bluetooth link
Timing Control	The PTA signal timing scheme is fully programmable relative to the Bluetooth packet timing.

2.6.7 WLAN Capability

Туре	Features
Capability	The WLAN device technology uses an internal coexistence interface to exchange request/grant with the BCA.
	Features:
	Packet-based request signaling with direction and priority information
	1-bit or 2-bit priority signaling to support 4 priority levels
	Multiple WLAN Rx request trigger sources, including early prediction
	 WLAN Tx request cancellation and abort if grant denied or revoked in middle of request
	802.11n A-MPDU treated as single packet
Packet	Programmable mask allows each frame type to be mapped to a priority
Classification	 Default setting puts response frames (ACK), beacons, and QoS frames as high priority
	WLAN Tx and Rx have separate priority masks
Queue	Programmable mask allows each transmit queue to be mapped to a priority
Classification	Queue-based mapping is optional for software-generated frames only



2.6.8 LTE (MWS) Capability

The device supports a Bluetooth SIG WCI-2 MWS coexistence signaling interface. The coexistence logical signaling is designed to enable a standard interface to allow an MWS device and a Coexistence Controller to exchange information and support cooperative coexistence.

The WCI-2 signals carry time-critical information such as the start point of an MWS frame. The logical coexistence signaling architecture also includes transparent data messaging and vendor specific data messaging mechanism to enable passing information to and from the collocated MWS device and Coexistence Controller when long latency (tens of milliseconds) cannot be tolerated.

For further information please refer to ⇒ 2.6.4 WCI-2 Interface.

Coexistence Signals

The logical signals assist in time alignment, protecting MWS from interference and maximizing the usability of the Bluetooth radio.

Time-Critical Coexistence Signals

Signal Name	Direction
FRAME_SYNC	MWS to Bluetooth
BT_RX_PRI	Bluetooth to MWS
BT_TX_ON	Bluetooth to MWS
802_RX_PRI	Bluetooth to MWS
802_TX_ON	Bluetooth to MWS
MWS_PATTERN	MWS to Bluetooth
MWS_RX	MWS to Bluetooth
MWS_TX	MWS to Bluetooth
MWS_INACTIVITY_DURATION	MWS to Bluetooth
MWS_SCAN_FREQUENCY_OFFSET	MWS to Bluetooth
MWS_TX_PRIL (MWS TX Priority Level)	MWS to Bluetooth
MWS_RX_PRIL (MWS RX Priority Level)	MWS to Bluetooth

2.6.9 ZigBee (MWS) Coexistence Capability

ZigBee is based on the IEEE 802.15.4 standard and it is used by a suite of communication protocols to create Personal Area Networks (PANs) supporting home automation, lighting control, etc. ZigBee radios operate in the 2.4 GHz ISM band worldwide. Unlike Bluetooth, the ZigBee specification does not use AFH. When coexisting with WLAN/Bluetooth in the 2.4 GHz band, it is important to avoid co-channel (IB) operation of these radios.

The device re-uses the MWS coexistence interface to support ZigBee coexistence. The coexistence logical signaling is used to allow a ZigBee device and a WLAN/Bluetooth combo device to exchange information and support cooperative coexistence.

Coexistence Signals

The logical signals used for ZigBee and WLAN/Bluetooth coexistence are a subset of the LTE coexistence signaling. Considering the lower data rate of ZigBee packets, a lower baud rate may be chosen for the 2-wire UART physical interface. The BCA supports 3-way arbitration among ZigBee/WLAN/Bluetooth requests.

Coexistence Signals

Signal Name	Direction
MWS_RX	MWS to Bluetooth
MWS_TX	MWS to Bluetooth
MWS_PATTERN	MWS to Bluetooth
MWS_RX_PRI	MWS to Bluetooth
MWS_TX_PRI	MWS to Bluetooth
802_RX_PRI	Bluetooth to MWS
802_TX_ON	Bluetooth to MWS
BT_RX_PRI	Bluetooth to MWS
BT_TX_ON	Bluetooth to MWS



2.7 WLAN

Туре	Features
IEEE 802.11/	802.11 data rates 1 Mbps and 2 Mbps (DSSS)
Standards	• 802.11b data rates 5.5 Mbps and 11 Mbps (CCK)
	 802.11a/g data rates 6 Mbps, 9 Mbps, 12 Mbps, 18 Mbps, 24 Mbps, 36 Mbps, 48 Mbps, and 54 Mbps (OFDM)
	802.11b/g performance enhancements
	 802.11n/ac with maximum data rates up to 86.7 Mbps (20 MHz channel), 200 Mbps (40 MHz channel), 433 Mbps (80 MHz channel)
	802.11d international roaming
	802.11e quality of service (QoS)
	802.11h transmit power control
	802.11h DFS radar pulse detection
	802.11i enhanced security (WEP, WPA, WPA2)
	802.11k radio resource measurement
	802.11mc precise indoor location and navigation
	802.11n block acknowledgment extension
	802.11r fast hand-off for AP roaming
	802.11u Hotspot 2.0 (STA mode only)
	802.11v TIM frame transmission/reception
	802.11w protected management frames
	Support clients (stations) implementing IEEE Power Save mode
WLAN MAC	Frame exchange at the MAC level to deliver data
	Received frame filtering and validation (CRC)
	Generation of MAC header and trailer information (MPDUs)
	Fragmentation of data frames (MSDUs)
	Access mechanism support for fair access to shared wireless medium through:
	Distributed Coordination Function (DCF)Enhanced Distributed Channel Access (EDCA)
	A-MPDU aggregation/de-aggregation (supports 802.11ac single-MPDU A-MPDU)
	20 MHz, 40 MHz, and 80 MHz channel coexistence
	RIFS burst receive
	Management information base
	Radio resource measurement
	Quality of service
	Block acknowledgement
	802.11ac downlink MU-MIMO (receive)
	Dynamic frequency selection
	TIM frame Tx and Rx
	Multiple BSS/Station
	Transmit rate adaption
	Transmit rate adaption Transmit power control

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Туре	Features
WLAN Baseband	 802.11ac 1×1 SISO (WLAN SoC with SISO RF radio) Backward compatibility with legacy 802.11a/b/g/n technology WLAN/Bluetooth LNA sharing PHY data rates up to 433 Mbps 20 MHz bandwidth/channel, 40 MHz bandwidth/channel, upper/lower 20 MHz bandwidth in 40 MHz channel, and 20 MHz duplicate legacy bandwidth in 40 MHz channel mode operation 80 MHz bandwidth/channel, 4 positions of 20 MHz bandwidth in 80 MHz channel, upper/lower 40 MHz bandwidth in 80 MHz channel, 20 MHz quadruplicate legacy bandwidth in 80 MHz channel mode operation Modulation and Coding Scheme 802.11n: MCS 0 ~ 7 and MCS 32 (duplicate 6 Mbps) 802.11ac: MCS 0~9 NSTS = 1 Dynamic frequency selection (radar detection) Enhanced radar detection for short and long pulse radar Enhanced AGC scheme for DFS channel Japan DFS requirement for W53 and W56 802.11k Radio resource measurement 802.11n/ac optional features: 20 MHz, 40 MHz, and 80 MHz coexistence with middle-packet detection (Gl detection) for enhancd CCA Space-Time-Block-Coding (STBC) one spatial stream reception LDPC transmission and reception for both 802.11n and 802.11ac 256 QAM (MCS 8, 9) modulation (optional support for 802.11ac MCS 9 in 20 MHz using LDPC) Short Guard Interval RIFS on receive path for 802.11n packets Explicit Beamformee support
	 802.11ac multi-user beamformee 802.11n Greenfield Tx/Rx MU-PPDUs (receive) 802.11mc locationing Power save features
WLAN Radio	 Integrated direct-conversion radio 20 MHz, 40 MHz, and 80 MHz channel bandwidth Shared WLAN/Bluetooth receive input scheme for 2.4 GHz band Rx Path On-chip gain selectable LNA with optimized noise figure and power consumption High dynamic range AGC function in receive mode Tx Path Internal PA with power control Optimized Tx gain distribution for linearity and noise performance Local Oscillator with fine channel step

Туре	Features
WLAN Encryption	 WEP 64-bit and 128-bit encryption with hardware TKIP processing (WPA) AES-CCMP hardware implementation as part of 802.11i security standard (WPA2) Advanced encryption standard (AES)/Counter-Mode/CBC-MAC Protocol (CCMP) AES-Cipher-Based Message Authentication Code (CMAC) as part of the 802.11w security standard WLAN Authentication and Privacy Infrastructure (WAPI)

Operation Modes

Parameter	Operation Mo	de			Specification
Standard Conformance	IEEE 802.11/IEE	EE 802.11b			
	IEEE 802.11a				
	IEEE 802.11g				
	IEEE 802.11n				
	IEEE 802.11ac				
Modulation	IEEE 802.11a				OFDM
	IEEE 802.11b				DSSS/CCK
	IEEE 802.11g				OFDM
	IEEE 802.11n				OFDM at MCS0~7 and MCS32 (duplicate 6 Mbps)
	IEEE 802.11ac				OFDM at MCS0~9
Physical layer data rates	IEEE 802.11				1 Mbps, 2 Mbps at DSSS
	IEEE 802.11b				5.5 Mbps, 11 Mbps at DSSS/CCK
Supported data rates	IEEE 802.11g				[6, 9, 12, 18, 24, 36, 48, 54] Mbps
	IEEE 802.11a				[6, 9, 12, 18, 24, 36, 48, 54] Mbps
	IEEE 802.11n	MCS0~7	HT20	LGI	[6.5, 13, 19.5, 26, 39, 52, 58.5, 65] Mbps
				SGI	[7.2, 14.4, 21.7, 28.9, 43.3, 57.8, 65, 72.2] Mbps
			HT40	LGI	[13.5, 27, 40.5, 54, 81, 108, 121.5, 135] Mbps
				SGI	[15, 30, 45, 60, 90, 120, 135, 150] Mbps
	IEEE 802.11ac	MCS0~8	HT20	LGI	[6.5, 13, 19.5, 26, 39, 52, 58.5, 65, 78] Mbps
				SGI	[7.2, 14.4, 21.7, 28.9, 43.3, 57.8, 65, 72.2, 86.7] Mbps
		MCS0~9	HT40	LGI	[13.5, 27, 40.5, 54, 81, 108, 121.5, 135, 162, 180] Mbps
				SGI	[15, 30, 45, 60, 90, 120, 135, 150, 180, 200] Mbps
			VHT80	LGI	[29.3, 58.5, 87.8, 117, 175.5, 234, 263.3, 292.5, 351, 390] Mbps
				SGI	[32.5, 65, 97.5, 130, 195, 260, 292.5, 325, 390, 433.3] Mbps

Parameter	Operation Mode	Specification				
Supported bandwidth	IEEE 802.11n	20 MHz, 40 MHz (BW)				
	IEEE 802.11ac	20 MHz, 40 MHz, 80 MHz (BW)				
Supported channel mode operation	IEEE 802.11n	20 MHz BW/channel, 40 MHz BW/channel, upper/lower 20 MHz BW at 40 MHz channel, 20 MHz duplicate legacy BW at 40 MHz channel				
	IEEE 802.11ac	20 MHz BW/channel, 40 MHz BW/channel, 80 MHz BW/channel, upper/lower 20 MHz BW at 40 MHz channel, 20 MHz duplicate legacy BW at 40 MHz channel, 4 positions of 20 MHz BW at 80 MHz channel, upper/lower 40 MHz BW at 80 MHz channel, 20 MHz quadruplicate legacy BW at 80 MHz channel				
Supported Guard Interval	IEEE 802.11n	400 ns (SGI), 800 ns (LGI)				
	IEEE 802.11ac	400 ns (SGI), 800 ns (LGI)				

Channels and Frequencies (without Regulatory Restrictions)

2.4 GHz – IEEE 8	802.11b/g/n				
20 MHz Channel	ls		40 MHz Channel	s	
Channel	Frequency	Unit	Channel	Frequency	Unit
1	2 412	MHz	1 to 5	2 422	MHz
2	2 417	MHz	2 to 6	2 427	MHz
3	2 422	MHz	3 to 7	2 432	MHz
4	2 427	MHz	4 to 8	2 437	MHz
5	2 432	MHz	5 to 9	2 442	MHz
6	2 437	MHz	6 to 10	2 447	MHz
7	2 442	MHz	7 to 11	2 452	MHz
8	2 447	MHz			
9	2 452	MHz			
10	2 457	MHz			
11	2 462	MHz			
12	2 467	MHz			
13	2 472	MHz			

5 GHz – IEEE 802.11a/n/ac									
20 MHz Channel	ls		40 MHz Channels						
Channel	Frequency	Unit	Channel	Frequency	Unit				
36	5 180	MHz	36 to 40	5 190	MHz				
40	5 200	MHz	44 to 48	5 230	MHz				
44	5 220	MHz	52 to 56	5 270	MHz				

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20 MHz Channe	Is		40 MHz Channel	s	
Channel	Frequency	Unit	Channel	Frequency	Unit
48	5 240	MHz	60 to 64	5 310	MHz
52	5 260	MHz			
56	5 280	MHz			
60	5 300	MHz			
64	5 320	MHz			
100	5 500	MHz	100 to 104	5 510	MHz
104	5 520	MHz	108 to 112	5 550	MHz
108	5 540	MHz	116 to 120	5 590	MHz
112	5 560	MHz	124 to 128	5 630	MHz
116	5 580	MHz	132 to 136	5 670	MHz
120	5 600	MHz	149 to 153	5 755	MHz
124	5 620	MHz	157 to 161	5 795	MHz
128	5 640	MHz			
132	5 660	MHz			
136	5 680	MHz			
140	5 700	MHz			
149	5 745	MHz			
153	5 765	MHz			
157	5 785	MHz			
161	5 805	MHz			
165	5 825	MHz			

5 GHz – IEEE 80	2.11a/n/ac				
80 MHz Channe	ls				
Channel	Frequency	Unit	Channel	Frequency	Unit
36 to 48	5 210	MHz			
52 to 64	5 290	MHz			
100 to 112	5 530	MHz			
116 to 128	5 610	MHz			
132 to 144	5 690	MHz			
149 to 161	5 775	MHz			

5 GHz – IEEE 80	5 GHz – IEEE 802.11a/n/ac (India and additional UNII Channels)									
20 MHz Channe	ls		40 MHz Channels							
Channel	Frequency	Unit	Channel	Frequency	Unit					
144	5 720	MHz	68 to 72	5 350	MHz					
169 ⁵	5 845	MHz	76 to 80	5 390	MHz					
173 ⁵	5 865	MHz	84 to 88	5 430	MHz					
177	5 885	MHz	92 to 96	5 470	MHz					
181	5 905	MHz	140 to 144	5 710	MHz					
			165 to 169	5 835	MHz					
			169 to 173 ⁶	5 855	MHz					
			173 to 177	5 875	MHz					

5 GHz – IEEE 80	5 GHz – IEEE 802.11a/n/ac (India and additional UNII Channels)									
80 MHz Channel	ls									
Channel	Frequency	Unit	Channel	Frequency	Unit					
68 to 80	5 370	MHz								
84 to 96	5 410	MHz								
165 to 177	5 855	MHz								

-

⁵ India channels that can be used in other countries as well.

⁶ India use only.

PAN9028 Bluetooth Module

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Channel Tables based on Regulatory Domain/Country

	5 (Hz IE	EE 802	.11a/n/a	ac															
	802.11 Operation Mode					11a	11n/ac	20M	11ac 20M	11n/ac	40M	11ac 40M		11ac 80M						
	Data Rates				Rates	6M - 54M	MCS0 - MCS4	MCS5 - MCS7	MCS8	MCS0 - MCS4	MCS5 - MCS7	MCS8 - MCS9	MCS0 - MCS4	MCS5 - MCS7	MCS8 - MCS9		0 = disable	1 = enable	Device Mode	Y = Yes/N = No
Model Variant ⁷	Channel 20M	Channel 40M	Channel 80M	Frequenz	Unit	TX Power	(maximum)						Unit	DFS	Passive	Master	Client			
MR	36	38		5 180	MHz	16	16	15	12	16	15	11	14	12	10	dBm	0	0	Υ	Υ
	40		42	5 200	MHz	16	16	15	12	16	15	11	14	12	10	dBm	0	0	Υ	Υ
	44	46	72	5 220	MHz	16	16	15	12	16	15	11	14	12	10	dBm	0	0	Υ	Υ
	48	40		5 240	MHz	16	16	15	12	16	15	11	14	12	10	dBm	0	0	Υ	Υ
	52	54	58	5 260	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	56			5 280	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	60	62	30	5 300	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	64			5 320	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	100	102		5 500	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	104	102	106	5 520	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	108	110	100	5 540	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	112	110		5 560	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	116	118		5 580	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	120	110	122	5 600	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	124	126	122	5 620	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	128	120		5 640	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	132	104		5 660	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	136	134	400	5 680	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	140	4.40	138	5 700	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	144	142		5 720	MHz	-	-	-	-	-	-	-	-	-	-	dBm	-	-	N	N
	149	4=1		5 745	MHz	10	10	10	10	10	10	10	10	10	10	dBm	0	0	Υ	Υ
	153	151	155	5 765	MHz	10	10	10	10	10	10	10	10	10	10	dBm	0	0	Υ	Υ
	157	159		5 785	MHz	10	10	10	10	10	10	10	10	10	10	dBm	0	0	Υ	Υ

⁷ The country related module variants are using a channel table with TX Power, DFS, and Passive Scan settings, which is pre-stored and locked in the OTP memory of the module and cannot be changed by host driver API. Please find the model variants restricted to a particular regulatory domain at the variant table of Ordering Information.

Product Specification Rev. 1.1

2 Overview

PAN9028 Bluetooth Module

	5 GHz IEEE 802.11a/n/ac																			
802.11 Operation Mode			11a	11n/ac	20M	11ac 20M	11n/ac	40M	11ac 40M	,	11ac 80M									
				Data	Rates	6M - 54M	MCS0 - MCS4	MCS5 - MCS7	MCS8	MCS0 - MCS4	MCS5 - MCS7	MCS8 - MCS9	MCS0 - MCS4	MCS5 - MCS7	MCS8 - MCS9		0 = disable	1 = enable	Device Mode	Y = Yes/N = No
Model Variant ⁷	Channel 20M	Channel 40M	Channel 80M	Frequenz	Unit	TX Power	(maximum)									Unit	DFS	Passive	Master	Client
	161			5 805	MHz	10	10	10	10	10	10	10	10	10	10	dBm	0	0	Υ	Υ
	165	-	-	5 825	MHz	10	10	10	10	-	-	-	-	-	-	dBm	0	0	Υ	Υ

2.8 Bluetooth

Туре	Features
General	 Supports Bluetooth 5 Shared LNA for Bluetooth Digital Audio Interface including PCM interface for voice application Bluetooth and WLAN coexistence
Bluetooth Classic (BR/EDR)	 Bluetooth Classic with Bluetooth Class 1 support Baseband and radio Basic Rate (BR) and Enhanced Data Rate (EDR) packet types with 1 Mbps (GFSK), 2 Mbps (π/4-DQPSK) and 3 Mbps (8DPSK) Fully functional Bluetooth baseband with: Adaptive Frequency Hopping (AFH) Forward error correction Header error control Access code correlation CRC Encryption bit stream generation Whitening Adaptive Frequency Hopping (AFH) including Packet Loss Rate (PLR)
	 Interlaced scan for faster connection setup Simultaneous 7 active ACL connection support Automatic ACL packet type selection Full master and slave piconet support

PAN9028 Bluetooth Module

2 Overview

Туре	Features
туре	 Scatternet support Standard UART and SDIO HCI transport layer 3 SCO/eSCO links with hardware accelerated audio signal processing and hardware supported PPEC algorithm for speech quality improvement All standard SCO/eSCO voice coding All standard pairing, authentication, link key, and encryption operations Standard Bluetooth power saving mechanism (i.e. hold, sniff modes, and sniff-sub rating) Enhanced Power Control (EPC) Channel Quality Driven (CQD) data rate Wideband Speech (WBS) support (1 WBS link) Encryption (AES) support LTE/MWS coexistence Bluetooth 2.1 to 5.0 Core Specification Support Packet types ACL (DM1, DH1, DM3, DH3, DM5, DH5, 2-DH1, 2-DH3, 2-DH5, 3-DH1, 3-DH3, 3-DH5) SCO (HV1, HC3) eSCO (EV3, EV4, EV5, 2EV3, 3EV3, 2EV5, 3EV5) Profile Support A2DP Source/Sink AVRCP Target/Controller HFP Dev/gateway OPP Server/Client PAN Traffic SPP HID PBAP
Bluetooth Low Energy (LE)	 Broadcaster, Observer, Central, and Peripheral roles Supports link layer topology to be master and slave (connects up to 16 links) Shared RF with BR/EDR Encryption AES support Hardware support for intelligent Adaptive Frequency Hopping (AFH) LE Privacy 1.2 LE Secure Connection LE Data Length Extension LE Advertising Length Extension High Duty Cycle Directed Advertising 2 Mbps LE Bluetooth Low Energy 4.0 to 5.0 Support Direction Finding Connectionless Angle of Departure (AoD) Connection-oriented Angle of Arrival (AoA) Profile Support GATT HOGP



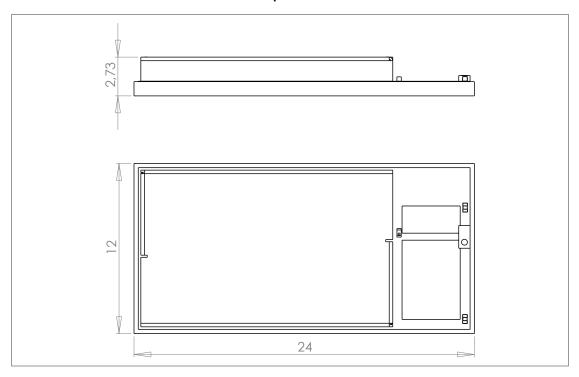
3 Detailed Description

3.1 Dimensions



All dimensions are in millimeters.

Top View



No.	Item	Dimension	Tolerance	Remark
1	Width	12.00	±0.35	
2	Length	24.00	±0.35	
3	Height	2.75	±0.20	With case

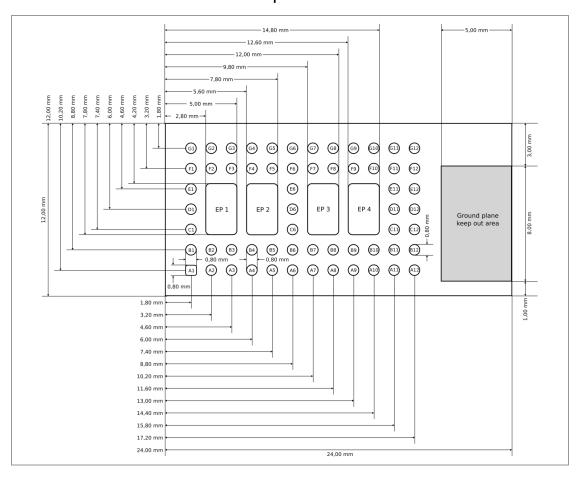


3.2 Footprint



The outer dimensions have a tolerance of ± 0.35 mm.

Top View

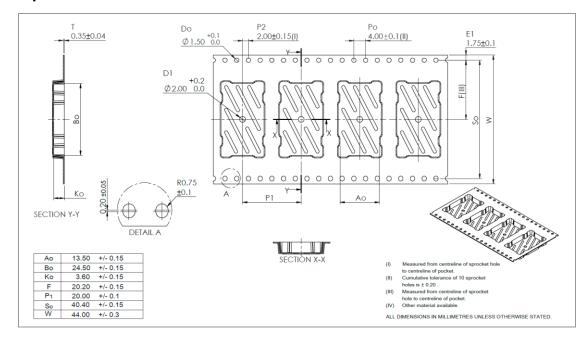




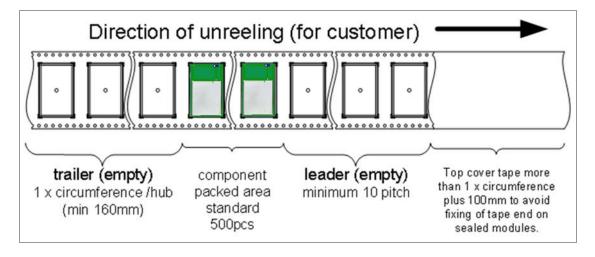
3.3 Packaging

The module is a mass production status product and will be delivered in the package described below.

3.3.1 Tape Dimensions



3.3.2 Packing in Tape

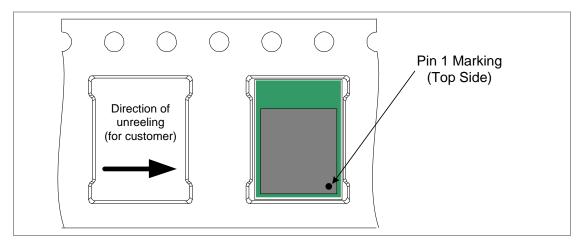


Empty spaces in the component packed area shall be less than two per reel and those spaces shall not be consecutive.

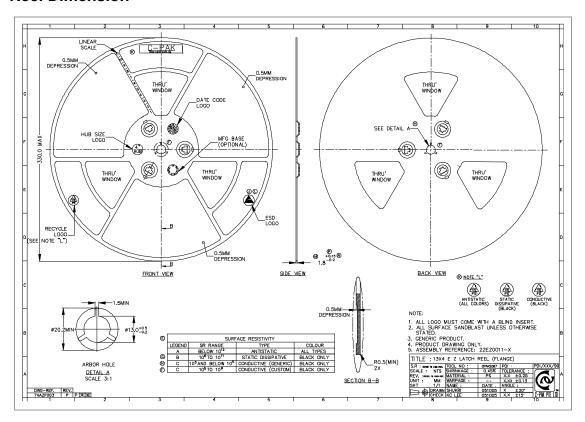
The top cover tape shall not be found on reel holes and it shall not stick out from the reel.



3.3.3 Component Direction



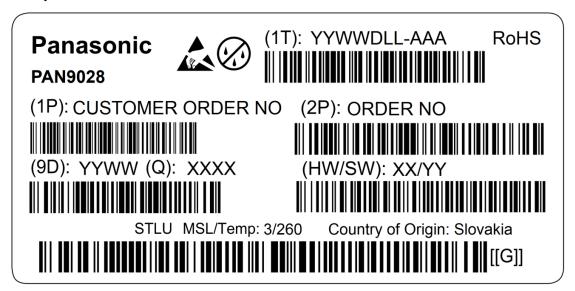
3.3.4 Reel Dimension





3.3.5 Package Label

Example:



(1T) Lot code

(1P) Customer order number, if applicable

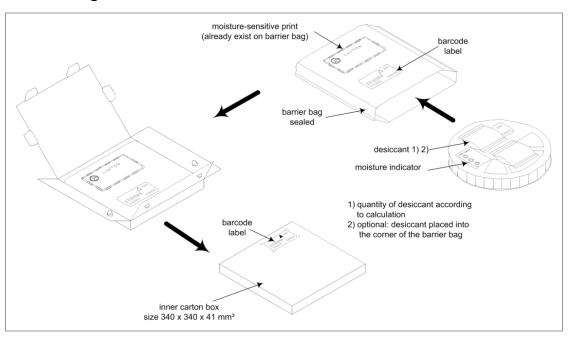
(2P) Order number Date code

(9D)

(Q) Quantity

(HW/SW) Hardware/software version

3.3.6 **Total Package**





3.4 Case Marking

Example:



- 10
- 1 Brand name
- 2 Hardware/software version
- 3 Engineering Sample (optional)
- 4 Order number
- 5 Lot code
- 6 Serial number
- 7 WLAN MAC address
- 8 BD address
- 9 (Reserved)
- 10 Marking for Pin 1
- 11 2D barcode, for internal usage only



4 Specification



All specifications are over temperature and process, unless indicated otherwise.

4.1 Default Test Conditions

1

Temperature: $25 \,^{\circ}\text{C} \pm 10 \,^{\circ}\text{C}$ Humidity: $40 \text{ to } 85 \,^{\circ}\text{RH}$

Supply Voltage: +3.3 V (for module variant ENWF490xA1EF)

Supply Voltage: +3.3 V / +2.2 V / +1.8 V / +1.1 V (for module variant

ENWF490xA2EF)

4.2 Absolute Maximum Ratings



The maximum ratings may not be exceeded under any circumstances, not even momentarily or individually, as permanent damage to the module may result.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
T _{STOR}	Storage temperature		-40		+85	°C
Vesd	robustness	All pads, according to human body model (HBM), JEDEC STD 22, method A114			1 000	V
		According to charged device model (CDM), JEDEC STD 22, method C101			500	V
P _{RF}	RF input level				+2	dBm
V _{DD3V3}	Maximum	Maximum power supply voltage from any pin with respect to		3.3	4	V
V _{DD2V2}	voltage			2.2	2.3	V
V _{DD1V8}	Vss (GND)		1.8	1.98	V	
V _{DD1V1}				1.1	1.21	V
V _{IOSD}				1.8	2.2	V
				3.3	4	V
Vio				1.8	2.2	V
				3.3	4	V
V _{RF_SW1/2}				3.3	4	V
V _{PMIC_EN}				3.3	V _{DD3V3}	V

4 Specification

4.3 Recommended Operating Conditions



The maximum ratings may not be exceeded under any circumstances, not even momentarily or individually, as permanent damage to the module may result.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
TA	Ambient operating temperature range	Extended grade	-30		+85	°C
V _{DD3V3}	3.3 V supply voltage	V _{DD} voltage on pins F2, F3	3.07	3.3	3.53	V
V _{DD2V2}	2.2 V supply voltage	V _{DD} voltage on pins G1, G2 (only for module variant ENWF940[x]A2EF)	2.09	2.2	2.26	V
V _{DD1V8}	1.8 V supply voltage	V _{DD} voltage on pin G4 (only for module variant ENWF940[x]A2EF)	1.71	1.8	1.89	V
V _{DD1V1}	1.1 V supply voltage	V _{DD} voltage on pin A3 (only for module variant ENWF940[x]A2EF)	1.05	1.1	1.15	V
V _{IOSD}	Digital I/O VIOSD supply	Pin F4 with 1.8 V operation ⇒ SDIO Pin Functions	1.67	1.8	1.92	V
	voltage ⁸	Pin F4 with 3.3 V operation ⇒ SDIO Pin Functions	3.07	3.3	3.53	V
Vio	Digital I/O VIO	Pin G3 with 1.8 V operation	1.67	1.8	1.92	V
	supply voltage ⁸	Pin G3 with 3.3 V operation	3.07	3.3	3.53	V
V _{RF_SW1/2}	VRF_SW1/2 switch voltage	Pin A11, B11 with 3.3 V logical level switch operation ⇒ RF-Switch Pin Function	3.07	3.3	3.6	V
V _{PMIC_EN}	PMIC Enable	High Level Input Voltage Threshold (only for module variant ENWF940[x]A1EF)	1.2	3.3	3.6	V
		Low Level Input Voltage Threshold (only for module variant ENWF940[x]A1EF)	0	0	0.4	V

⁸ 1.8 V or 3.3 V supply voltage possible.



Digital Pin Characteristics

V_{IO} with 1.8 V Operation⁹

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V_{IH}	High level input voltage	1.8 V operation (V _{IO} = 1.8 V)	0.7 V _{IO}		V _{IO} + 0.4	V
V_{IL}	Low level input voltage	1.8 V operation (V _{IO} = 1.8 V)	-0.4		0.3 V _{IO}	V
V_{HYS}	Input hysteresis		100			mV
V _{OH}	High level output voltage	1.8 V operation (V _{IO} = 1.8 V)	V _{IO} - 0.4			V
V _{HO}	Low level output voltage	1.8 V operation (V _{IO} = 1.8 V)			0.4	V

V_{IO} with 3.3 V Operation⁹

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{IH}	High level input voltage	3.3 V operation (V _{IO} = 3.3 V)	0.7 V _{IO}		V _{IO} + 0.4	V
V _{IL}	Low level input voltage	3.3 V operation ($V_{IO} = 3.3 \text{ V}$)	-0.4		0.3 V _{IO}	V
V _{HYS}	Input hysteresis		100			mV
V _{OH}	High level output voltage	3.3 V operation (V _{IO} = 3.3 V)	V _{IO} - 0.4			V
V _{HO}	Low level output voltage	3.3 V operation (V _{IO} = 3.3 V)			0.4	V

V_{IOSD} with 1.8 V Operation for SDIO I/F⁹

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{IH}	High level input voltage	1.8 V operation (V _{IOSD} = 1.8 V)	0.7 V _{IO}		V _{IO} + 0.4	V
V _{IL}	Low level input voltage	1.8 V operation (V _{IOSD} = 1.8 V)	-0.4		0.3 V _{IO}	V
V _{HYS}	Input hysteresis		100			mV
V _{OH}	High level output voltage	1.8 V operation (V _{IOSD} = 1.8 V)	V _{IO} - 0.4			V
V _{HO}	Low level output voltage	1.8 V operation (V _{IOSD} = 1.8 V)			0.4	V

⁹ The capacitive load should not be larger than 50 pF for all I/Os when using the default driver strength settings. Large capacitive loads increase the overall current consumption.



V_{IOSD} with 3.3 V Operation for SDIO I/F⁹

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V _{IH}	High level input voltage	3.3 V operation (V _{IOSD} = 3.3 V)	0.7 V _{IO}		V _{IO} + 0.4	V
V _{IL}	Low level input voltage	3.3 V operation (V _{IOSD} = 3.3 V)	-0.4		0.3 V _{IO}	V
V _{HYS}	Input hysteresis		100			mV
V _{OH}	High level output voltage	3.3 V operation (V _{IOSD} = 3.3 V)	V _{IO} - 0.4			V
V _{HO}	Low level output voltage	3.3 V operation (V _{IOSD} = 3.3 V)			0.4	V

4.4 Current Consumption

4.4.1 For ENWF940[x]A1EF



The current consumption depends on the user scenario and on the setup and timing in the power modes. Following current consumptions are valid for module variant ENWF940[x]A1EF.

Assume $V_{DD} = 3.3 \text{ V}$, $T_{amb} = 25 ^{\circ}\text{C}$, if nothing else stated.

Parameter	Condition		Min.	Тур.	Max.	Unit
I _{VDD3V3} @ PMIC_EN	Power Down	Grounding of PMIC_EN pin		0.25		mA
I _{VDD3V3} @ DeepSleep	Deep Sleep	Low-power state used in sleep state (Wifi & BT)		0.50		mA
I _{VDD3V3} @ Firmware Init	Firmware Initialization	Device Initialization			800	mA

WLAN Current Consumption

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
I _{VDD3V3} @ TX	Active Transmit ¹⁰	P_{TX} = +16 dBm for 5 GHz band 802.11a at 54 Mbps		330		mA
		P_{TX} = +15 dBm for 5 GHz band 802.11n 40 MHz at 150 Mbps		280		mA
		P_{TX} = +10 dBm for 5 GHz band 802.11ac 80 MHz at 433 Mbps		240		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11b at 11 Mbps		290		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11g at 54 Mbps		250		mA

¹⁰ Peak values for specified output power level and data rate with UDP traffic between the AP and Device (STA).

4 Specification

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
		P_{TX} = +16 dBm for 2.4 GHz band 802.11n 20 MHz at 72 Mbps		240		mA
I _{VDD3V3} @ RX	Active Receive ¹⁰	5 GHz band 802.11a at 54 Mbps		80		mA
		5 GHz band 802.11n 40 MHz at 150 Mbps		90		mA
		5 GHz band 802.11ac 80 MHz at 433 Mbps		100		mA
		2.4 GHz band 802.11b at 11 Mbps		70		mA
		2.4 GHz band 802.11g at 54 Mbps		70		mA
		2.4 GHz band 802.11n 20 MHz at 72 Mbps		70		mA

Bluetooth Current Consumption

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
I _{VDD3V3} @ TX	BT SCO HV3	Peak, P _{TX} = +4 dBm		25		mA
	Peak LE	Peak, P _{TX} = +0 dBm		25		mA
I _{VDD3V3} @ RX	BT SCO HV3	Peak		20		mA
	Peak LE	Peak		23		mA
I _{SCAN BT}	Page & Inquiry Scan	Average		0.8		mA
I _{ADV LE}	LE Advertise	Interval = 1.28s, Average		0.6		mA

4.4.2 For ENWF940[x]A2EF



The current consumption depends on the user scenario, on the setup, and timing in the power modes. Following current consumptions are valid for module variant ENWF940[x]A2EF.

Assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V and $T_{amb}=25$ °C, if nothing else stated.

4 Specification

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
I _{VDD2V2}	Deep Sleep	Low-power state used in sleep state (Wifi & BT)		0.003		mA
I _{VDD1V8}		Low-power state used in sleep state (Wifi & BT)		0.050		mA
I _{VDD1V1}		Low-power state used in sleep state (Wifi & BT)		1.200		mA
I _{VDD1V1}		Low-power state used in sleep state (Wifi & BT), Reduced core voltage from 1.1V to 0.8V after set to Deep Sleep		0.400		mA
I _{VDD2V2}	Firmware	Device Initialization			900	mA
I _{VDD1V8}	Initialization				200	mA
I _{VDD1V1}					200	mA

WLAN Current Consumption

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
I _{VDD2V2} @ TX	Active Transmit ¹⁰	P_{TX} = +16 for 5 GHz band 802.11a at 54 Mbps		220		mA
		P_{TX} = +15 dBm for 5 GHz band 802.11n 40 MHz at 150 Mbps		160		mA
		P_{TX} = +10 dBm for 5 GHz band 802.11ac 80 MHz at 433 Mbps		110		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11b at 11 Mbps		240		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11g at 54 Mbps		180		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11n 20 MHz at 72 Mbps		180		mA
I _{VDD2V2} @ RX	Active	5 GHz band 802.11a at 54 Mbps		0		mA
	Receive ¹⁰	5 GHz band 802.11n 40 MHz at 150 Mbps		0		mA
		5 GHz band 802.11ac 80 MHz at 433 Mbps		0		mA
		2.4 GHz band 802.11b at 11 Mbps		0		mA
		2.4 GHz band 802.11g at 54 Mbps		0		mA
		2.4 GHz band 802.11n 20 MHz at 72 Mbps		0		mA
I _{VDD1V8} @ TX	Active Transmit ¹⁰	P_{TX} = +16 dBm for 5 GHz band 802.11a at 54 Mbps		120		mA
		P_{TX} = +15 dBm for 5 GHz band 802.11n 40 MHz at 150 Mbps		120		mA
		P_{TX} = +10 dBm for 5 GHz band 802.11ac 80 MHz at 433 Mbps		120		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11b at 11 Mbps		70		mA

4 Specification

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
		P_{TX} = +16 dBm for 2.4 GHz band 802.11g at 54 Mbps		70		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11n 20 MHz at 72 Mbps		70		mA
I _{VDD1V8} @ RX	Active	5 GHz band 802.11a at 54 Mbps		70		mA
	Receive ¹⁰	5 GHz band 802.11n 40 MHz at 150 Mbps		70		mA
		5 GHz band 802.11ac 80 MHz at 433 Mbps		70		mA
		2.4 GHz band 802.11b at 11 Mbps		50		mA
		2.4 GHz band 802.11g at 54 Mbps		50		mA
		2.4 GHz band 802.11n 20 MHz at 72 Mbps		50		mA
I _{VDD1V1} @ TX	Active Transmit ¹⁰	P_{TX} = +16 dBm for 5 GHz band 802.11a at 54 Mbps		120		mA
		P_{TX} = +15 dBm for 5 GHz band 802.11n 40 MHz at 150 Mbps		120		mA
		P_{TX} = +10 dBm for 5 GHz band 802.11ac 80 MHz at 433 Mbps		130		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11b at 11 Mbps		120		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11g at 54 Mbps		110		mA
		P_{TX} = +16 dBm for 2.4 GHz band 802.11n 20 MHz at 72 Mbps		110		mA
I _{VDD1V1 @ RX}	Active	5 GHz band 802.11a at 6 Mbps		70		mA
	Receive ¹⁰	5 GHz band 802.11n 20 MHz at 72 Mbps		70		mA
		5 GHz band 802.11ac 80 MHz at 433 Mbps		70		mA
		2.4 GHz band 802.11b at 11 Mbps		60		mA
		2.4 GHz band 802.11g at 54 Mbps		60		mA
		2.4 GHz band 802.11n 20 MHz at 72 Mbps		60		mA

Bluetooth Current Consumption

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
I _{VDD2V2 @ TX}	BT SCO HV3	Peak, P _{TX} = +4 dBm		0		mA
	Peak LE	Peak, P _{TX} = +0 dBm		0		mA
I _{VDD2V2 @ RX}	BT SCO HV3	Peak		0		mA
	Peak LE	Peak		0		mA
I _{VDD1V8 @ TX}	BT SCO HV3	Peak, P _{TX} = +4 dBm		20		mA
155110011	Peak LE	Peak, P _{TX} = +0 dBm		20		mA
I _{VDD1V8 @ RX}	BT SCO HV3	Peak		20		mA

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PAN9028 Bluetooth Module

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
	Peak LE	Peak		20		mA
I _{VDD1V1 @ TX}	BT SCO HV3	Peak, P _{TX} = +4 dBm		25		mA
	Peak LE	Peak, P _{TX} = +0 dBm		25		mA
I _{VDD1V1 @ RX}	BT SCO HV3	Peak		20		mA
	Peak LE	Peak		20		mA
I _{VDD2V2} SCAN BT	Page & Inquiry Scan	Average		0		mA
VDD1V8 SCAN BT	Page & Inquiry Scan	Average		0.5		mA
I _{VDD1V1} SCAN BT	Page & Inquiry Scan	Average		0.9		mA
I _{VDD2V2} ADV LE	LE Advertise	Interval = 1.28s, Average		0		mA
I _{VDD1V8 ADV LE}	LE Advertise	Interval = 1.28s, Average		0.3		mA
I _{VDD1V1} ADV LE	LE Advertise	Interval = 1.28s, Average		0.8		mA

4.5 Internal Operating Frequencies

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
f _{SYSCLK1}	CPU1/System/ Encryption clock speed	Refers to clock speed of SoC's CPU1			256	MHz
f _{SYSCLK2}	CPU2	Refers to clock speed of SoC's CPU2			64	MHz
f _{REFCLK1}	Crystal fundamental frequency	Frequency tolerance < ±10 ppm over operating temperature and process		26		MHz
f _{SLEEPCLK} (only for module variant ENWF940[x]A1E F)	Sleep Clock frequency	Frequency tolerance < ±30 ppm over operating temperature, aging and process, CMOS input clock signal type		32.768		kHz



4.6 External Sleep Clock Specifications

An external sleep clock of $32.768\,kHz$ can be used for lowest current consumption in sleep mode. Voltage level of external sleep clock must be the same value which is used for Pin G4 (V_{IO}).

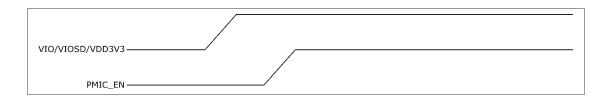
Parameter	Min.	Тур.	Max.	Units
Clock frequency range/accuracy		32.768		kHz
CMOS input clock signal type				
• ±250 ppm (initial, aging, temperature)				
Phase noise requirement (at 100 kHz)		-125		dBc/Hz
Cycle jitter		1.5		ns (RMS)
Slew rate limit (10 % to 90 %)			100	ns
Duty cycle tolerance	20		80	%

4.7 Power-up Sequence

For Module Variant ENWF940[x]A1EF:

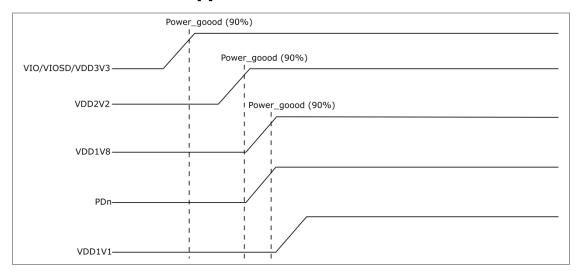


A minimum time of 100 ms is required after PMIC_EN is de-asserted (low) and before it is asserted (high).



4 Specification

For Module Variant ENWF940[x]A2EF:



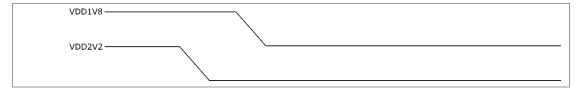
- V_{IO}/V_{IOSD}/V_{DD3V3} must be good (90 %) before or at the same time all other power supplies start ramping up.
- V_{IO}/V_{IOSD}/V_{DD3V3} must be good (90%) before or at the same time PDn starts ramping up.
- V_{DD2V2} must be good (90 %) before or at the same time V_{DD1V8} starts ramping up.
- It is recommended to start ramping up VDD1V8 ≤ 1ms after V_{DD2V2} ramps up.
- V_{DD1V8} must be good (90 %) before or at the same time VDD1V1 starts ramping up.
- Ramp-up time of V_{IO}/V_{IOSD}/V_{DD3V3} must be < 100 ms.
- Ramp-up time of V_{DD2V2} / V_{DD1V8} must be < 100 ms.
- Ramp-up time of V_{DD1V1} must be < 5ms.
- All supplies must be monotonic.

4.8 Power-down Sequence

For Module Variant ENWF940[x]A1EF:

Power down sequencing is performed from internal power management IC after PMIC_EN pin is pulled to low state.

For Module Variant ENWF940[x]A2EF:



- It is recommended to ramp down VDD1V8 after VDD2V2 ramps down.
- It is recommended to discharge all of the power supplies to less than 0.2V to reduce leakage
- PDn must be asserted when powering down the module



4.9 Power Good (only for Module Variant ENWF940[x]A1EF)



Do not connect the power good outputs (PG1, PG2, and PGLDO) if they are not used.

The PAN9028 contains power good comparators, which pull the signal to a logical low level, when the associated output voltage drops below 90 % of its regulated value. Also, when the associated rising output voltage is above 95 % of its regulated value, the power good comparators pull the signal to a logical low level.

No.	Pin Name	Pin Type	Logical Level		
			Low (typ. 0 V)	High (typ. 3.3 V)	
B1	PG1	Output signal	1.1 V voltage supply not stabilized	1.1 V voltage supply stabilized	
D1	PG2	Output signal	2.2 V voltage supply not stabilized	2.2 V voltage supply stabilized	
C1	PGLDO	Output signal	1.8 V voltage supply not stabilized	1.8 V voltage supply stabilized	

4.10 Interfaces

4.10.1 Host Interface

4.10.1.1 SDIO Interface



The SDIO Interface pins are powered from the V_{IOSD} voltage supply with either 3.3 V or 1.8 V. The SDIO electrical specifications are identical for the 1-bit and 4-bit SDIO modes.

SDIO Timing Data - Default and High-Speed Modes (V_{IOSD} 3.3 V)^{11,12}

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
f _{PP}	Clock frequency	Normal	0		25	MHz
		High-speed	0		50	MHz
T _{WL}	Clock low time	Normal	10			ns
		High-speed	7			ns

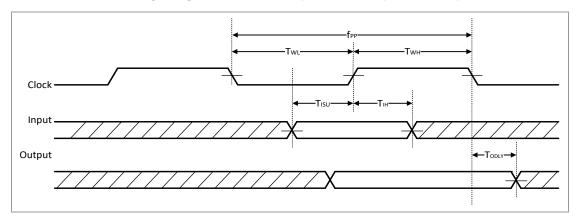
¹¹ For SDIO 2.0 running at 50 MHz clock frequency, a supply voltage VIOSD of 1.8 V is recommended.

¹² For SDIO 2.0 running at 25 MHz clock frequency, either 1.8 V or 3.3 V can be used.

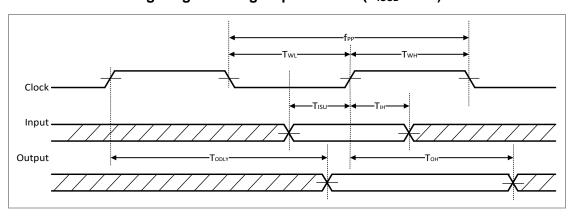
4 Specification

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
T _{WH}	Clock high time	Normal	10			ns
		High-speed	7			ns
T _{ISU}	Input setup time	Normal	5			ns
		High-speed	6			ns
T _{IH}	Input hold time	Normal	5			ns
		High-speed	2			ns
T _{ODLY}	Output delay time	Normal			14	ns
	CL ≤ 40 pF (1 card)	High-speed			14	ns
Тон	Output hold time	High-speed	2.5			ns

SDIO Protocol Timing Diagram – Default Speed Mode (V_{IOSD} 3.3 V)



SDIO Protocol Timing Diagram - High-Speed Mode (V_{IOSD} 3.3 V)

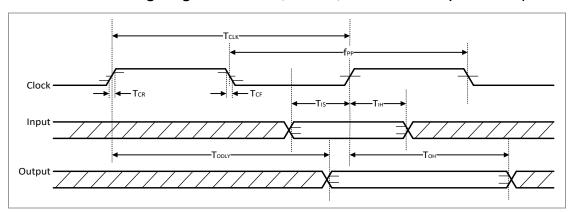




SDIO Timing Data - SDR12, SDR25, SDR50 Modes (VIOSD 1.8 V)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
f_{PP}	Clock frequency	SDR12/SDR25/SDR50	25		100	MHz
T _{IS}	Input setup time	SDR12/SDR25/SDR50	3			ns
T _{IH}	Input hold time	SDR12/SDR25/SDR50	0.8			ns
T _{CLK}	Clock time	SDR12/SDR25/SDR50	10		40	ns
T _{CR} , T _{CF}	Rise time, fall time T _{CR} , T _{CF} < 2 ns (max) at 100 MHz C _{CARD} = 10 pF	SDR12/SDR25/SDR50			0.2 T _{CLK}	ns
T _{ODLY}	Output delay time CL ≤ 30 pF	SDR12/SDR25/SDR50			7.5	ns
Тон	Output hold time CL ≤ 15 pF	SDR12/SDR25/SDR50	1.5			ns

SDIO Protocol Timing Diagram - SDR12, SDR25, SDR50 Modes (V_{IOSD} 1.8 V)

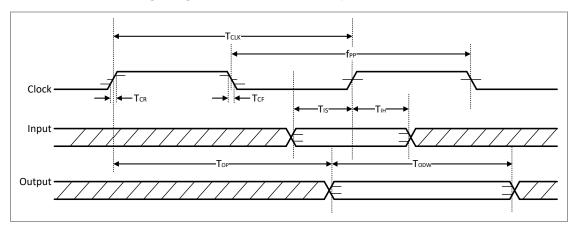


SDIO Timing Data - SDR104 Mode (V_{IOSD} 1.8 V)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
f_{PP}	Clock frequency	SDR104	0		208	MHz
T _{IS}	Input setup time	SDR104	1.4			ns
T _{IH}	Input hold time	SDR104	0.8			ns
T _{CLK}	Clock time	SDR104	4.8			ns
T_{CR} , T_{CF}	Rise time, fall time T _{CR} , T _{CF} < 0.96 ns (max) at 208 MHz C _{CARD} = 10 pF	SDR104			0.2 Tclk	ns
T _{OP}	Card output phase	SDR104	0		10	ns
T _{ODW}	Output timing of variable data window	SDR104	2.88			ns



SDIO Protocol Timing Diagram - SDR104 Mode (V_{IOSD} 1.8 V)



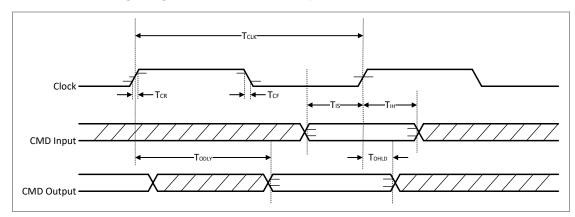
SDIO Timing Data - DDR50 Mode (V_{IOSD} 1.8 V)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
Clock						
T _{CLK}	Clock time 50 MHz (max) between rising edges	DDR50	20			ns
T _{CR} , T _{CF}	Rise time, fall time T _{CR} , T _{CF} < 4.00 ns (max) at 50 MHz C _{CARD} = 10 pF	DDR50			0.2 T _{CLK}	ns
Clock Duty		DDR50	45		55	%
CMD Input (referenced to clock rising ed	lge)				
T _{IS}	Input setup time C _{CARD} ≤ 10 pF (1 card)	DDR50	6			ns
Тін	Input hold time C _{CARD} ≤ 10 pF (1 card)	DDR50	0.8			ns
CMD Output	(referenced to clock rising	edge)				
T _{OLDY}	Output delay time during data transfer mode $C_L \le 30 \text{ pF (1 card)}$	DDR50			13.7	ns
T _{OHLD}	Output hold time $C_L \le 15 \text{ pF (1 card)}$	DDR50	1.5			ns
DAT[3:0] Inp	out (referenced to clock risin	g and falling edges)				
T _{IS2x}	Input setup time Ccard ≤ 10 pF (1 card)	DDR50	3			ns
T _{IH2x}	Input hold time $C_{CARD} \le 10 \text{ pF (1 card)}$	DDR50	0.8			ns

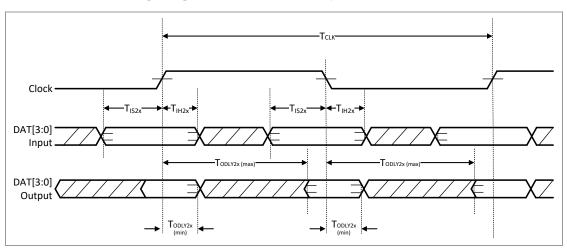
4 Specification

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
DAT[3:0] Outp	ut (referenced to clock risi	ing and falling edges)				
TODLY2x (max)	Output delay time during data transfer mode $C_L \le 25 pF (1 card)$	DDR50			7.0	ns
TODLY2x (min)	Output hold time C _L ≤ 15 pF (1 card)	DDR50	1.5			ns

SDIO CMD Timing Diagram - DDR50 Mode (V_{IOSD} 1.8 V, 50 MHz)



SDIO DAT[3:0] Timing Diagram - DDR50 Mode (V_{IOSD} 1.8 V, 50 MHz)





4.10.1.2 High-Speed UART Interface



The High-Speed UART Interface pins are powered from the V_{10} voltage supply with either 3.3 V or 1.8 V.

The UART interface operation includes:

- Support data input/output operations for peripheral devices connected through a standard UART interface
- 4-wire data transfer (RxD, TxD, RTS and CTS) or 6-wire data transfer (RxD, TxD, RTS, CTS, DSR, and DTR)
- Programmable baud rate (1 200 bps to 4 Mbps)
- Data format (LSB first)
- Data bit: (5 bit to 8 bit)
- Parity bit: (0 bit to 4 bit)
- Stop bit: (1 bit to 2 bit)

Interface Signals

Pin No.	Signal Name	Specification Name	Туре	Description
B8	UART_SOUT	TxD	Host Controller	Transmit data output
A8	UART_SIN	RxD	Interface (HCI)	Receive data input
A7	UART_RTS	RTS		Request to send (active low)
A6	UART_CTS	CTS		Clear to send (active low)
B6	UART_DSR	DSR	optional	Data set ready (active low)
B7	UART_DTR	DTR		Data terminal ready (active low)

Interface Transport Settings

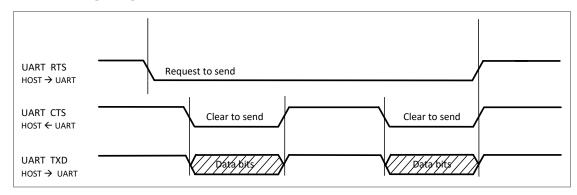
Item	Range	Default	Comment
Baud Rate	1 200 ~ 4 000 000	3 000 000	Baud
Data Bits	5~8	8	LSB first
Parity Bits	0~4	0	
Stop Bits	1/1.5/2	1	



Supported Baud Rates

Baud Rate				
1 200	2 400	4 800	9 600	19 200
38 400	57 600	76 800	115 200	230 400
460 800	500 000	921 600	1 000 000	1 382 400
1 500 000	1 843 200	2 000 000	2 100 000	2 764 800
3 000 000	3 250 000	3 692 300	4 000 000	

UART Timing Diagram



4.10.2 Peripheral Interface



The Peripheral Interface pins are powered from the V_{10} voltage supply with either 3.3 V or 1.8 V.

GPIO Interface

The General-Purpose I/O (GPIO) interface is used to implement user-defined input and output signals to and from the device, such as external interrupts and other user-defined I/Os.

Configurable GPIOs

Function	GPIO Pin Name									
	100	IO1	102	103	104	105	106	107	108	109
GPIO IN	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES
GPIO OUT	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES
IRQ IN	YES	YES	YES	YES	YES	YES	YES	YES	YES	YES
LED	NO	NO	YES	YES	NO	NO	NO	NO	NO	NO



Function		GPIO Pin Name									
	IO10 IO11 IO12 IO13 IO14 IO15					IO15	IO16	IO17	IO20		
GPIO IN	YES	YES	YES	YES	YES	YES	YES	YES	YES		
GPIO OUT	YES	YES	YES	YES	YES	YES	YES	YES	YES		
IRQ IN	YES	YES	YES	YES	YES	YES	YES	YES	YES		
LED	NO	NO	NO	NO	NO	NO	NO	NO	NO		

LED Mode

Symbol	Parameter	Condition	Тур.	Units
I _{OH}	Switching current high	Tristate on pin (requires pull-up)	Tristate when driving high	mA
I _{OL}	Switching current low	At 0.4 V	10	mA

4.10.3 Audio Interface: PCM Interface

Interface Signals

Pin No.	Signal Name	Specification Name	Туре	Description
F7	PCM_DOUT	DOUT	Output	PCM data
E1	PCM_CLK	CLK	Input/Output	PCM clock signal, output if PCM master, input if PCM slave
E1	PCM_MCLK	MCLK	Output	PCM clock signal (optional), optional clock used for some codecs, derived from PCM_CLK
E11	PCM_DIN	DIN	Input	PCM data
F6	PCM_SYNC	SYNC	Input/Output	PCM Sync pulse signal, output if PCM master, input if PCM slave

Modes of Operation

The PCM Interface supports two modes of operation:

- PCM master
- PCM slave

When in PCM master mode, the interface generates a 2 MHz or a 2.048 MHz PCM_CLK and a 8 kHz PCM_SYNC signal. An alternative PCM master mode is available that uses an externally generated PCM_CLK, but still generate the 8 kHz PCM_SYNC. The external PCM_CLK must have a frequency that is an integer multiple of 8 kHz. Supported frequencies are in the 512 kHz to 4 MHz range.

When in PCM slave mode, the interface has both PCM_CLK and PCM_SYNC as inputs, thereby letting another unit on the PCM bus generate the signals.

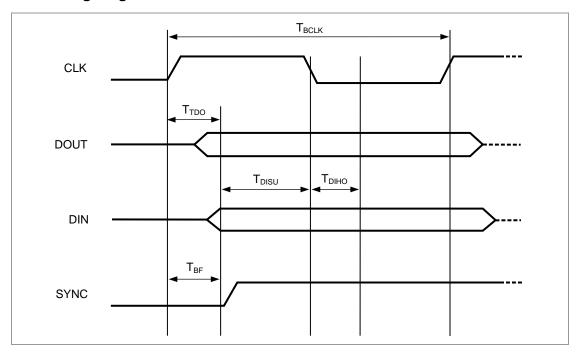


The PCM interface consists of up to four PCM slots (time-divided) preceded by a PCM sync signal. Each PCM slot can be either 8 bits or 16 bits wide. The slots can be separated in time, but they are not required to follow immediately after another. The timing is relative to PCM_SYNC.

PCM Timing Data - Master Mode

Symbol	Min.	Тур.	Max.	Units
FBCLK		2/2.048		MHz
Duty CycleвLCк	0.4	0.5	0.6	
TBCLK rise/fall		3		ns
T _{DO}			15	ns
Tolsu	20			ns
Тыно	15			ns
Твғ			15	ns

PCM Timing Diagram – Master Mode

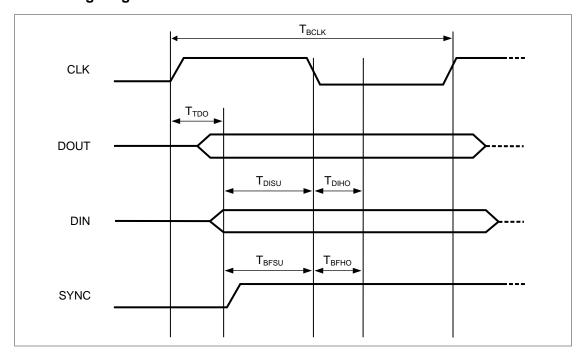




PCM Timing Data – Slave Mode

Symbol	Min.	Тур.	Max.	Units
FBCLK		2/2.048		MHz
Duty Cycle _{BLCK}	0.4	0.5	0.6	
TBCLK rise/fall		3		ns
T _{DO}			30	ns
T _{DISU}	15			ns
Тыно	10			ns
T _{BFSU}	15			ns
Твгно	10			

PCM Timing Diagram – Slave Mode



4.10.4 Coexistence Interface



The Peripheral Interface pins are powered from the $V_{\text{IO}}\,\text{voltage}$ supply with either 3.3 V or 1.8 V.

For DC specifications please refer to "Digital Pin Characteristics" \Rightarrow 4.3 Recommended Operating Conditions.

Panasonic

4.11 RF Electrical Characteristics

4.11.1 WLAN Radio Specification

Receive Mode

Parameter	Condition	Min.	Тур.	Max.	Units
RF frequency range	2.4 GHz – IEEE 802.11b/g/n	2 400		2 500	MHz
	5 GHz – IEEE 802.11a/n/ac	4 900		5 925	MHz

Transmit Mode

Parameter	Condition	Min.	Тур.	Max.	Units
RF frequency range	2.4 GHz – IEEE 802.11b/g/n	2 400		2 500	MHz
	5 GHz – IEEE 802.11a/n/ac	4 900		5 925	MHz

4.11.2 WLAN RF Characteristics

4.11.2.1 RF Characteristics for IEEE 802.11b



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume V_{DD3V3} = 3.3 V, V_{DD2V2} = 2.2 V, V_{DD1V8} = 1.8 V, V_{DD1V1} = 1.1 V, V_{IOSD} = 3.3 V, V_{IO} = 3.3 V and T_{amb} = 25 °C, if nothing else stated.

 50Ω terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range			2 400		2 483.5	MHz
Carrier frequency tolerance			-25		+25	ppm
Transmit output power				+16		dBm
Spectrum mask	f _C ± 11 MHz				-30	dBr
	f _C ± 22 MHz				-50	dBr
Power-on/Power-down ramp					2	μs
RF Carrier suppression					-15	dB
Error Vector Magnitude (EVM)	Peak				35	%
Minimum receive sensitivity	1 Mbps (DSSS)	FER ≤ 8 %		-97		dBm
	2 Mbps (DSSS)	FER ≤ 8 %		-93	-80	dBm
	5.5 Mbps (CCK)	FER ≤ 8 %		-91		dBm
	11 Mbps (CCK)	FER ≤ 8 %		-88	-76	dBm
Maximum input level		FER ≤ 8 %			-10	dBm
Adjacent channel rejection		FER ≤ 8 %	35			dB

4.11.2.2 RF Characteristics for IEEE 802.11g



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V, $V_{IOSD}=3.3$ V, $V_{IO}=3.3$ V and $T_{amb}=25$ °C, if nothing else stated.

 50Ω terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	2.4 GHz		2 400		2 483.5	MHz
Carrier frequency tolerance			-25		+25	ppm
Transmit output power	6 Mbps ~ 36 Mbps			+16		dBm
	48 Mbps ~ 54 Mbps			+16		dBm
Spectrum mask	f _C ± 11 MHz				-20	dBr
	f _C ± 20 MHz				-28	dBr
	f _C ± 30 MHz				-40	dBr
Transmitter center frequency leakage					-15	dB
Transmitter Spectral Flatness			-4		+4	dB
EVM Constellation Error (EVM)	BPSK, CR 1/2 (6 Mbps)				-5	dB
	BPSK, CR 3/4 (9 Mbps)				-8	dB
	QPSK, CR 1/2 (12 Mbps)				-10	dB
	QPSK, CR 3/4 (18 Mbps)				-13	dB
	16-QAM, CR 1/2 (24 Mbps)				-16	dB
	16-QAM, CR 3/4 (36 Mbps)				-19	dB
	64-QAM, CR 2/3 (48 Mbps)				-22	dB
	64-QAM, CR 3/4 (54 Mbps)				-25	dB
Minimum receive sensitivity	BPSK, CR 1/2 (6 Mbps)	PER ≤ 10 %		-89	-82	dBm
	BPSK, CR 3/4 (9 Mbps)	PER ≤ 10 %		-89	-81	dBm
	QPSK, CR 1/2 (12 Mbps)	PER ≤ 10 %		-88	-79	dBm
	QPSK, CR 3/4 (18 Mbps)	PER ≤ 10 %		-86	-77	dBm
	16-QAM, CR 1/2 (24 Mbps)	PER ≤ 10 %		-83	-74	dBm
	16-QAM, CR 3/4 (36 Mbps)	PER ≤ 10 %		-80	-70	dBm
	64-QAM, CR 2/3 (48 Mbps)	PER ≤ 10 %		-76	-66	dBm
	64-QAM, CR 3/4 (54 Mbps)	PER ≤ 10 %		-74	-65	dBm
Maximum input level		PER ≤ 10 %			-20	dBm
Adjacent channel rejection		PER ≤ 10 %	16			dB
		PER ≤ 10 %	-1			dB

4 Specification

PAN9028 Bluetooth Module

4.11.2.3 RF Characteristics for IEEE 802.11n (BW 20 MHz, 2.4 GHz)



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3\ V,\ V_{DD2V2}=2.2\ V,\ V_{DD1V8}=1.8\ V,\ V_{DD1V1}=1.1\ V,\ V_{IOSD}=3.3\ V,\ V_{IO}=3.3\ V$ and $T_{amb}=25\ ^{\circ}C,$ if nothing else stated.

 50Ω terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	2.4 GHz		2 400		2 483.5	MHz
Carrier frequency tolerance			-25		+25	ppm
Transmit output power	MCS0 ~ MCS2			+16		dBm
	MCS3 ~ MCS4			+16		dBm
	MCS5 ~ MCS7			+16		dBm
Spectrum mask	f _C ± 11 MHz				-20	dBr
	f _C ± 20 MHz				-28	dBr
	f _C ± 30 MHz				-45	dBr
Transmitter center frequency leakage					-15	dB
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (MCS0)				-5	dB
	QPSK, CR 1/2 (MCS1)				-10	dB
	QPSK, CR 3/4 (MCS2)				-13	dB
	16-QAM, CR 1/2 (MCS3)				-16	dB
	16-QAM, CR 3/4 (MCS4)				-19	dB
	64-QAM, CR 2/3 (MCS5)				-22	dB
	64-QAM, CR 3/4 (MCS6)				-25	dB
	64-QAM, CR 5/6 (MCS7)				-27	dB
Minimum receive sensitivity ¹³	6.5 Mbps (MCS0)	PER ≤ 10 %		-89	-82	dBm
	13 Mbps (MCS1)	PER ≤ 10 %		-87	-79	dBm
	19.5 Mbps (MCS2)	PER ≤ 10 %		-84	-77	dBm
	26 Mbps (MCS3)	PER ≤ 10 %		-81	-74	dBm
	39 Mbps (MCS4)	PER ≤ 10 %		-78	-70	dBm
	52 Mbps (MCS5)	PER ≤ 10 %		-75	-66	dBm
	58.5 Mbps (MCS6)	PER ≤ 10 %		-73	-65	dBm
	65 Mbps (MCS7)	PER ≤ 10 %		-71	-64	dBm

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 $^{^{13}}$ The minimum sensitivity levels apply only to non-STBC modes, MCS 0~7, 800 ns LGI, and BCC.

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Parameter		Condition	Min.	Тур.	Max.	Units
Maximum input level		PER ≤ 10 %			-20	dBm
Adjacent channel rejection ¹⁴	65 Mbps (MCS7)	PER ≤ 10 %	-2			dB

4.11.2.4 RF Characteristics for IEEE 802.11n (BW 40 MHz, 2.4 GHz)



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V, $V_{IOSD}=3.3$ V, $V_{IO}=3.3$ V and $T_{amb}=25$ °C, if nothing else stated.

 $50\,\Omega$ terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	2.4 GHz		2 400		2 483.5	MHz
Carrier frequency tolerance			-25		+25	ppm
Transmit output power	MCS0 ~ MCS2			+14		dBm
	MCS3 ~ MCS4			+14		dBm
	MCS5 ~ MCS7			+13		dBm
Spectrum mask	f _C ± 21 MHz				-20	dBr
	f _C ± 40 MHz				-28	dBr
	f _C ± 60 MHz				-45	dBr
Transmitter center frequency leakage					-20	dB
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (MCS0)				-5	dB
	QPSK, CR 1/2 (MCS1)				-10	dB
	QPSK, CR 3/4 (MCS2)				-13	dB
	16-QAM, CR 1/2 (MCS3)				-16	dB
	16-QAM, CR 3/4 (MCS4)				-19	dB
	64-QAM, CR 2/3 (MCS5)				-22	dB
	64-QAM, CR 3/4 (MCS6)				-25	dB
	64-QAM, CR 5/6 (MCS7)				-27	dB
Minimum receive sensitivity ¹³	13.5 Mbps (MCS0)	PER ≤ 10 %		-83	-79	dBm
	27 Mbps (MCS1)	PER ≤ 10 %		-83	-76	dBm
	40.5 Mbps (MCS2)	PER ≤ 10 %		-80	-74	dBm
	54 Mbps (MCS3)	PER ≤ 10 %		-78	-71	dBm
	81 Mbps (MCS4)	PER ≤ 10 %		-73	-67	dBm

 $^{^{14}}$ The adjacent channel rejection levels apply only to non-STBC modes, MCS 0~7, 800 ns LGI, and BCC.

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4 Specification

Parameter		Condition	Min.	Тур.	Max.	Units
	108 Mbps (MCS5)	PER ≤ 10 %		-70	-63	dBm
	121.5 Mbps (MCS6)	PER ≤ 10 %		-68	-62	dBm
	135 Mbps (MCS7)	PER ≤ 10 %		-66	-61	dBm
Maximum input level		PER ≤ 10 %			-20	dBm
Adjacent channel rejection ¹⁴	135 Mbps (MCS7)	PER ≤ 10 %	-2			dB

4.11.2.5 RF Characteristics for IEEE 802.11n (BW 20 MHz, 5 GHz)



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V, $V_{IOSD}=3.3$ V, $V_{IO}=3.3$ V and $T_{amb}=25$ °C, if nothing else stated.

 $50\,\Omega$ terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	5 GHz U-NII-1		5 150		5 250	MHz
	5 GHz U-NII-2A		5 250		5 350	MHz
	5 GHz U-NII-2C		5 470		5 725	MHz
	5 GHz U-NII-3		5 725		5 825	MHz
Carrier frequency tolerance			-20		+20	ppm
Transmit output power	MCS0 ~ MCS2			+16		dBm
	MCS3 ~ MCS4			+16		dBm
	MCS5 ~ MCS7			+15		dBm
Spectrum mask	f _C ± 11 MHz				-20	dBr
	f _C ± 20 MHz				-28	dBr
	f _C ± 30 MHz				-40	dBr
Transmitter center frequency leakage					-15	dB
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (MCS0)				-5	dB
	QPSK, CR 1/2 (MCS1)				-10	dB
	QPSK, CR 3/4 (MCS2)				-13	dB
	16-QAM, CR 1/2 (MCS3)				-16	dB
	16-QAM, CR 3/4 (MCS4)				-19	dB
	64-QAM, CR 2/3 (MCS5)				-22	dB
	64-QAM, CR 3/4 (MCS6)				-25	dB
	64-QAM, CR 5/6 (MCS7)				-27	dB

Parameter		Condition	Min.	Тур.	Max.	Units
Minimum receive sensitivity ¹³	6.5 Mbps (MCS0)	PER ≤ 10 %		-90	-82	dBm
	13 Mbps (MCS1)	PER ≤ 10 %		-87	-79	dBm
	19.5 Mbps (MCS2)	PER ≤ 10 %		-85	-77	dBm
	26 Mbps (MCS3)	PER ≤ 10 %		-82	-74	dBm
	39 Mbps (MCS4)	PER ≤ 10 %		-80	-70	dBm
	52 Mbps (MCS5)	PER ≤ 10 %		-75	-66	dBm
	58.5 Mbps (MCS6)	PER ≤ 10 %		-74	-65	dBm
	65 Mbps (MCS7)	PER ≤ 10 %		-72	-64	dBm
Maximum input level		PER ≤ 10 %			-30	dBm
Adjacent channel rejection ¹⁴	65 Mbps (MCS7)	PER ≤ 10 %	-2			dB

4.11.2.6 RF Characteristics for IEEE 802.11n (BW 40 MHz, 5 GHz)



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V, $V_{IOSD}=3.3$ V, $V_{IO}=3.3$ V and $T_{amb}=25$ °C, if nothing else stated.

 50Ω terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	5 GHz U-NII-1		5 150		5 250	MHz
	5 GHz U-NII-2A		5 250		5 350	MHz
	5 GHz U-NII-2C		5 470		5 725	MHz
	5 GHz U-NII-3		5 725		5 825	MHz
Carrier frequency tolerance			-20		+20	ppm
Transmit output power	MCS0 ~ MCS2			+16		dBm
	MCS3 ~ MCS4			+16		dBm
	MCS5 ~ MCS7			+15		dBm
Spectrum mask	f _C ± 21 MHz				-20	dBr
	f _C ± 40 MHz				-28	dBr
	f _C ± 60 MHz				-40	dBr
Transmitter center frequency leakage					-20	dB
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (MCS0)				-5	dB
	QPSK, CR 1/2 (MCS1)				-10	dB
	QPSK, CR 3/4 (MCS2)				-13	dB
	16-QAM, CR 1/2 (MCS3)				-16	dB

Parameter		Condition	Min.	Тур.	Max.	Units
	16-QAM, CR 3/4 (MCS4)				-19	dB
	64-QAM, CR 2/3 (MCS5)				-22	dB
	64-QAM, CR 3/4 (MCS6)				-25	dB
	64-QAM, CR 5/6 (MCS7)				-27	dB
Minimum receive sensitivity ¹³	13.5 Mbps (MCS0)	PER ≤ 10 %		-87	-79	dBm
	27 Mbps (MCS1)	PER ≤ 10 %		-84	-76	dBm
	40.5 Mbps (MCS2)	PER ≤ 10 %		-82	-74	dBm
	54 Mbps (MCS3)	PER ≤ 10 %		-79	-71	dBm
	81 Mbps (MCS4)	PER ≤ 10 %		-77	-67	dBm
	108 Mbps (MCS5)	PER ≤ 10 %		-73	-63	dBm
	121.5 Mbps (MCS6)	PER ≤ 10 %		-71	-62	dBm
	135 Mbps (MCS7)	PER ≤ 10 %		-70	-61	dBm
Maximum input level		PER ≤ 10 %			-30	dBm
Adjacent channel rejection ¹⁴	135 Mbps (MCS7)	PER ≤ 10 %	-2			dB

4.11.2.7 RF Characteristics for IEEE 802.11ac (BW 20 MHz)



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V, $V_{IOSD}=3.3$ V, $V_{IO}=3.3$ V and $T_{amb}=25$ °C, if nothing else stated.

 $50\,\Omega$ terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	5 GHz U-NII-1		5 150		5 250	MHz
	5 GHz U-NII-2A		5 250		5 350	MHz
	5 GHz U-NII-2C		5 470		5 725	MHz
	5 GHz U-NII-3		5 725		5 825	MHz
Carrier frequency tolerance			-20		+20	ppm
Transmit output power	MCS0 ~ MCS2			+16		dBm
	MCS3 ~ MCS4			+16		dBm
	MCS5 ~ MCS7			+15		dBm
	MCS8			+12		dBm
Spectrum mask	f _C ± 11 MHz				-20	dBr
	f _C ± 20 MHz				-28	dBr
	f _C ± 30 MHz				-40	dBr
Transmitter center frequency leakage	P is transmit power per antenna in dBm				P-17.48	dB

Parameter		Condition	Min.	Тур.	Max.	Units
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (MCS0)				-5	dB
	QPSK, CR 1/2 (MCS1)				-10	dB
	QPSK, CR 3/4 (MCS2)				-13	dB
	16-QAM, CR 1/2 (MCS3)				-16	dB
	16-QAM, CR 3/4 (MCS4)				-19	dB
	64-QAM, CR 2/3 (MCS5)				-22	dB
	64-QAM, CR 3/4 (MCS6)				-25	dB
	64-QAM, CR 5/6 (MCS7)				-27	dB
	256-QAM, CR 3/4 (MCS8)				-30	dB
Minimum receive sensitivity ¹³	6.5 Mbps (MCS0)	PER ≤ 10 %		-90	-82	dBm
	13 Mbps (MCS1)	PER ≤ 10 %		-87	-79	dBm
	19.5 Mbps (MCS2)	PER ≤ 10 %		-85	-77	dBm
	26 Mbps (MCS3)	PER ≤ 10 %		-82	-74	dBm
	39 Mbps (MCS4)	PER ≤ 10 %		-80	-70	dBm
	52 Mbps (MCS5)	PER ≤ 10 %		-75	-66	dBm
	58.5 Mbps (MCS6)	PER ≤ 10 %		-74	-65	dBm
	65 Mbps (MCS7)	PER ≤ 10 %		-72	-64	dBm
	78 Mbps (MCS 8)	PER ≤ 10 %		-68	-59	dBm
Maximum input level		PER ≤ 10 %			-30	dBm
Adjacent channel rejection ¹⁴	78 Mbps (MCS8)	PER ≤ 10 %	-7			dB

4.11.2.8 RF Characteristics for IEEE 802.11ac (BW 40 MHz)



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3\,V,\,V_{DD2V2}=2.2\,V,\,V_{DD1V8}=1.8\,V,\,V_{DD1V1}=1.1\,V,\,V_{IOSD}=3.3\,V,\,V_{IO}=3.3\,V$ and $T_{amb}=25\,^{\circ}C,\,if$ nothing else stated.

 50Ω terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	5 GHz U-NII-1		5 150		5 250	MHz
	5 GHz U-NII-2A		5 250		5 350	MHz
	5 GHz U-NII-2C		5 470		5 725	MHz
	5 GHz U-NII-3		5 725		5 825	MHz
Carrier frequency tolerance			-20		+20	ppm
Transmit output power	MCS0 ~ MCS2			+16		dBm

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Parameter		Condition	Min.	Тур.	Max.	Units
	MCS3 ~ MCS4			+16		dBm
	MCS5 ~ MCS7			+15		dBm
	MCS8 ~ MCS9			+11		dBm
Spectrum mask	f _C ± 21 MHz				-20	dBr
	f _C ± 40 MHz				-28	dBr
	f _C ± 60 MHz				-40	dBr
Transmitter center frequency leakage	P is transmit power per antenna in dBm				P-20.57	dB
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (MCS0)				-5	dB
	QPSK, CR 1/2 (MCS1)				-10	dB
	QPSK, CR 3/4 (MCS2)				-13	dB
	16-QAM, CR 1/2 (MCS3)				-16	dB
	16-QAM, CR 3/4 (MCS4)				-19	dB
	64-QAM, CR 2/3 (MCS5)				-22	dB
	64-QAM, CR 3/4 (MCS6)				-25	dB
	64-QAM, CR 5/6 (MCS7)				-27	dB
	256-QAM, CR 3/4 (MCS8)				-30	dB
	256-QAM, CR 5/6 (MCS9)				-32	dB
Minimum receive sensitivity ¹³	13.5 Mbps (MCS0)	PER ≤ 10 %		-87	-79	dBm
	27 Mbps (MCS1)	PER ≤ 10 %		-84	-76	dBm
	40.5 Mbps (MCS2)	PER ≤ 10 %		-82	-74	dBm
	54 Mbps (MCS3)	PER ≤ 10 %		-79	-71	dBm
	81 Mbps (MCS4)	PER ≤ 10 %		-77	-67	dBm
	108 Mbps (MCS5)	PER ≤ 10 %		-73	-63	dBm
	121.5 Mbps (MCS6)	PER ≤ 10 %		-71	-62	dBm
	135 Mbps (MCS7)	PER ≤ 10 %		-70	-61	dBm
	162 Mbps (MCS8)	PER ≤ 10 %		-65	-56	dBm
	180 Mbps (MCS9)	PER ≤ 10 %		-64	-54	dBm
Maximum input level		PER ≤ 10 %			-30	dBm
Adjacent channel rejection ¹⁴	180 Mbps (MCS9)	PER ≤ 10 %	-9			dB

4.11.2.9 RF Characteristics for IEEE 802.11ac (BW 80 MHz)



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V, $V_{IOSD}=3.3$ V, $V_{IO}=3.3$ V and $T_{amb}=25$ °C, if nothing else stated.

 50Ω terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	5 GHz U-NII-1		5 150		5 250	MHz
	5 GHz U-NII-2A		5 250		5 350	MHz
	5 GHz U-NII-2C		5 470		5 725	MHz
	5 GHz U-NII-3		5 725		5 825	MHz
Carrier frequency tolerance			-20		+20	ppm
Transmit output power	MCS0 ~ MCS2			+14		dBm
	MCS3 ~ MCS4			+14		dBm
	MCS5 ~ MCS7			+12		dBm
	MCS8 ~ MCS9			+10		dBm
Spectrum mask	f _C ± 41 MHz				-20	dBr
	$f_C \pm 80 MHz$				-28	dBr
	f _C ± 120 MHz				-40	dBr
Transmitter center frequency leakage	P is transmit power per antenna in dBm				P-23.84	dB
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (MCS0)				-5	dB
	QPSK, CR 1/2 (MCS1)				-10	dB
	QPSK, CR 3/4 (MCS2)				-13	dB
	16-QAM, CR 1/2 (MCS3)				-16	dB
	16-QAM, CR 3/4 (MCS4)				-19	dB
	64-QAM, CR 2/3 (MCS5)				-22	dB
	64-QAM, CR 3/4 (MCS6)				-25	dB
	64-QAM, CR 5/6 (MCS7)				-27	dB
	256-QAM, CR 3/4 (MCS8)				-30	dB
	256-QAM, CR 5/6 (MCS9)				-32	dB
Minimum receive sensitivity ¹³	29.3 Mbps (MCS0)	PER ≤ 10 %		-83	-76	dBm
	58.5 Mbps (MCS1)	PER ≤ 10 %		-81	-73	dBm
	87.8 Mbps (MCS2)	PER ≤ 10 %		-78	-71	dBm
	117 Mbps (MCS3)	PER ≤ 10 %		-76	-68	dBm
	175.5 Mbps (MCS4)	PER ≤ 10 %		-74	-64	dBm

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Parameter		Condition	Min.	Тур.	Max.	Units
	234 Mbps (MCS5)	PER ≤ 10 %		-69	-60	dBm
	263.3 Mbps (MCS6)	PER ≤ 10 %		-68	-59	dBm
	292.5 Mbps (MCS7)	PER ≤ 10 %		-66	-58	dBm
	351 Mbps (MCS8)	PER ≤ 10 %		-62	-53	dBm
	390 Mbps (MCS9)	PER ≤ 10 %		-59	-51	dBm
Maximum input level		PER ≤ 10 %			-30	dBm
Adjacent channel rejection ¹⁴	390 Mbps (MCS9)	PER ≤ 10 %	-9			dB

4.11.2.10 RF Characteristics for IEEE 802.11a



For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3\,V,\ V_{DD2V2}=2.2\,V,\ V_{DD1V8}=1.8\,V,\ V_{DD1V1}=1.1\,V,\ V_{IOSD}=3.3\,V,\ V_{IO}=3.3\,V\ and\ T_{amb}=25\,^{\circ}C,\ if\ nothing\ else\ stated.$

 50Ω terminal load connected to the RF connector.

Parameter		Condition	Min.	Тур.	Max.	Units
RF frequency range	5 GHz U-NII-1		5 150		5 250	MHz
	5 GHz U-NII-2A		5 250		5 350	MHz
	5 GHz U-NII-2C		5 470		5 725	MHz
	5 GHz U-NII-3		5 725		5 825	MHz
Carrier frequency tolerance			-20		+20	Ppm
Transmit output power	6 Mbps ~ 36 Mbps			+16		dBm
	48 Mbps ~ 54 Mbps			+16		dBm
Spectrum mask	f _C ± 11 MHz				-20	dBr
	f _C ± 20 MHz				-28	dBr
	f _C ± 30 MHz				-40	dBr
Transmitter center frequency leakage					-15	dB
Transmitter spectral flatness			-4		+4	dB
Constellation Error (EVM)	BPSK, CR 1/2 (6 Mbps)				-5	dB
	BPSK, CR 3/4 (9 Mbps)				-8	dB
	QPSK, CR 1/2 (12 Mbps)				-10	dB
	QPSK, CR 3/4 (18 Mbps)				-13	dB
	16-QAM, CR 1/2 (24 Mbps)				-16	dB
	16-QAM, CR 3/4 (36 Mbps)				-19	dB
	64-QAM, CR 2/3 (48 Mbps)				-22	dB
	64-QAM, CR 3/4 (54 Mbps)				-25	dB

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Parameter		Condition	Min.	Тур.	Max.	Units
Minimum receive sensitivity	BPSK, CR 1/2 (6 Mbps)	PER ≤ 10 %		-90	-82	dBm
	BPSK, CR 3/4 (9 Mbps)	PER ≤ 10 %		-90	-79	dBm
	QPSK, CR 1/2 (12 Mbps)	PER ≤ 10 %		-89	-77	dBm
	QPSK, CR 3/4 (18 Mbps)	PER ≤ 10 %		-87	-74	dBm
	16-QAM, CR 1/2 (24 Mbps)	PER ≤ 10 %		-85	-70	dBm
	16-QAM, CR 3/4 (36 Mbps)	PER ≤ 10 %		-81	-66	dBm
	64-QAM, CR 2/3 (48 Mbps)	PER ≤ 10 %		-77	-65	dBm
	64-QAM, CR 3/4 (54 Mbps)	PER ≤ 10 %		-75	-64	dBm
Maximum input level		PER ≤ 10 %			-30	dBm
Adjacent channel rejection	BPSK, CR 1/2 (6 Mbps)	PER ≤ 10 %	16			dB
	64-QAM, CR 3/4 (54 Mbps)	PER ≤ 10 %	-1			dB

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For module variant ENWF940[x]A1EF assume $V_{DD3V3}=3.3~V,~V_{IOSD}=3.3~V,~V_$

For module variant ENWF940[x]A2EF assume $V_{DD3V3}=3.3$ V, $V_{DD2V2}=2.2$ V, $V_{DD1V8}=1.8$ V, $V_{DD1V1}=1.1$ V, $V_{IOSD}=3.3$ V, $V_{IO}=3.3$ V and $T_{amb}=25$ °C, if nothing else stated.

 50Ω terminal load connected to the RF connector.

4.11.3.1 Receiver Section RF Characteristics

Parameter	Condition	Condition		Тур.	Max.	Units
RF frequency range					2 483.5	MHz
Interference Performance	nce Performance GFSK	C/I (Co-channel)			11	dB
(Basic Rate)	DCI 67 dDm	C/I (1 MHz)			0	dB
C/I Ratio	RSL = -67 dBm BER ≤ 0.1 %	C/I (2 MHz)			-30	dB
		C/I (3 MHz)			-40	dB
		C/I (Image)			-9	dB
		C/I (Image ± 1 MHz)			-20	dB

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Parameter	Condition		Min.	Тур.	Max.	Units
Interference Performance	π/4-DQPSK	C/I (Co-channel)			13	dB
(Enhanced Data Rate)	RSL= -67 dBm	C/I (1 MHz)			0	dB
C/I Ratio	BER ≤ 0.01 %	C/I (2 MHz)			-30	dB
		C/I (3 MHz)			-40	dB
		C/I (Image)			-7	dB
		C/I (Image ± 1 MHz)			-20	dB
	8-DPSK	C/I (Co-channel)			21	dB
	DCI 67 dDm	C/I (1 MHz)			5	dB
	RSL = -67 dBm BER \leq 0.01 %	C/I (2 MHz)			-25	dB
		C/I (3 MHz)			-33	dB
		C/I (Image)			0	dB
		C/I (Image ± 1 MHz)			-13	dB
Interference Performance	GFSK	C/I (Co-channel)			21	dB
(Low Energy)	RSL = -67 dBm	C/I (1 MHz)			15	dB
C/I Ratio	BER ≤ 0.1 %	C/I (2 MHz)			-17	dB
		C/I (3 MHz)			-27	dB
	1 Mbps	C/I (Image)			-9	dB
		C/I (Image ± 1 MHz)			-15	dB
	GFSK	C/I (Co-channel)			21	dB
	RSL = -67 dBm	C/I (2 MHz)			15	dB
	BER ≤ 0.1 %	C/I (3 MHz)			-17	dB
		C/I (6 MHz)			-27	dB
	2 Mbps	C/I (Image)			-9	dB
		C/I (Image ± 2 MHz)			-15	dB
Minimum Receive Sensitivity	BR, DH1	BER ≤ 0.1 %		-94	-70	dBm
	EDR, 2DH1	BER ≤ 0.01 %		-90	-70	dBm
	LE, GFSK	BER ≤ 0.1 %		-90	-70	dBm
Out-of-band blocking	GFSK	30 MHz to 2 000 MHz			-10	dB
(Basic Rate)	RSL = -67 dBm	2 GHz to 2.399 GHz			-27	dB
Interfering Signal Power	BER ≤ 0.1 %	2.484 GHz to 3 GHz			-27	dB
		3 GHz to 12.75 GHz			-10	dB
Out-of-band blocking	GFSK	30 MHz to 2 000 MHz			-30	dB
(Low Energy)	DCI _ 67 dD~	2 GHz to 2.399 GHz			-35	dB
Interfering Signal Power	RSL = -67 dBm BER ≤ 0.1 %	2.484 GHz to 3 GHz			-35	dB
		3 GHz to 12.75 GHz			-30	dB
RSSI Range	Resolution = 1 dB			-90	0	dB

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4.11.3.2 Transmitter Section RF Characteristics

Parameter	Condition		Min.	Тур.	Max.	Units
RF frequency range			2 400		2 483.5	MHz
Maximum output power	Basic Rat	te (BR)		+4		dBm
	Enhanced	d Data Rate (EDR)		+4		dBm
	Low ener	gy (LE)		+4		dBm
Gain range	Gain Con	trol		30		dB
Gain resolution				0.5		dB
Spurious emission (BR)	± 500 kHz	± 500 kHz			-20	dBc
(in-band)	± 2 MHz,	± 2 MHz, M-N = 2			-20	dBm
	± 3 MHz o	± 3 MHz or greater, M-N ≥ 3			-40	dBm
Spurious emission (EDR)	± 1 MHz	± 1 MHz			-26	dBc
(in-band)	± 1.5 MHz	± 1.5 MHz			-20	dBm
	± 2.5 MHz	Z			-40	dBm
Spurious emission (LE)	1 Mbps	± 2 MHz, M-N = 2			-20	dBm
(in-band)		± 3 MHz or greater, M-N ≥ 3			-30	dBm
	2 Mbps	± 4 MHz, M-N = 4			-20	dBm
		± 5 MHz, M-N = 5			-20	dBm
		± 6 MHz or greater, M-N ≥ 6			-30	dBm

4.12 Reliability Tests

The measurement should be done after the test device has been exposed to room temperature and humidity for one hour.

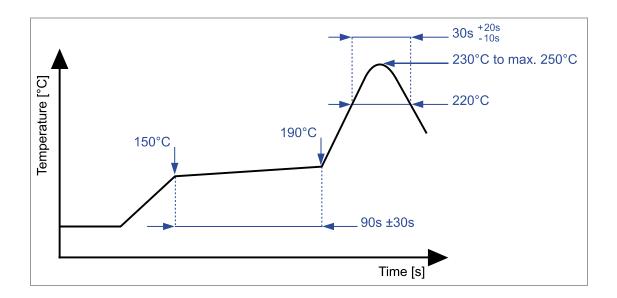
No.	Item	Limit	Condition
1	Vibration test	Electrical parameter are in specification	Freq.: 10~50 Hz; Amplitude: 1.5 mm; 20 min./cycle, 1 h each of XYZ axis
2	Shock test		Dropped 3 times onto hard wood from a height of 1 m
3	Heat cycle test		-30 °C for 30 min. and 85 °C for 30 min.; each temperature 300 cycles
4	Moisture test		60 °C, 90 % RH, 300 h
5	Low temperature test		-40 °C, 300 h
6	High temp. test		85 °C, 300 h

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4.13 Recommended Soldering Profile



- Reflow permissible cycles: 2
- Opposite side reflow is prohibited due to module weight
- More than 75 percent of the soldering area shall be coated by solder
- The soldering profiles should be adhered to in order to prevent electrical or mechanical damage
- Soldering profile assumes lead-free soldering





5 Cautions



Failure to follow the guidelines set forth in this document may result in degrading of the module functions and damage to the module.

5.1 Design Notes

- 1. Follow the conditions written in this specification, especially the control signals of this module.
- 2. The supply voltage should abide by the maximum ratings (⇒ 4.2 Absolute Maximum Ratings).
- 3. The supply voltage must be free of AC ripple voltage (for example from a battery or a low noise regulator output). For noisy supply voltages, provide a decoupling circuit (for example a ferrite in series connection and a bypass capacitor to ground of at least 47 μF directly at the module).
- 4. This module should not be mechanically stressed when installed.
- 5. Keep this module away from heat. Heat is the major cause of decreasing the life time of these modules.
- 6. Avoid assembly and use of the target equipment in conditions where the module temperature may exceed the maximum tolerance.
- 7. Keep this module away from other high frequency circuits.
- 8. Refer to the recommended pattern when designing a board.

5.2 Installation Notes

- Reflow soldering is possible twice based on the conditions set forth in
 ⇒ 4.13 Recommended Soldering Profile. Set up the temperature at the soldering portion
 of this module according to this reflow profile.
- 2. Carefully position the module so that the heat will not burn into printed circuit boards or affect other components that are susceptible to heat.
- 3. Carefully locate the module, to avoid an increased temperature caused by heat generated by neighboring components.
- 4. If a vinyl-covered wire comes into contact with the module, the wire cover will melt and generate toxic gas, damaging the insulation. Never allow contact between a vinyl cover and these modules to occur.
- 5. This module should not be mechanically stressed or vibrated when reflowed.
- 6. To repair the board by hand soldering, follow the conditions set forth in this chapter.
- 7. Do not wash this product.
- 8. Pressing on parts of the metal cover or fastening objects to the metal will cause damage to the module.



5.3 Usage Condition Notes

- Take measures to protect the module against static electricity.
 If pulses or transient loads (a large load, which is suddenly applied) are applied to the modules, check and evaluate their operation before assembly of the final products.
- 2. Do not use dropped modules.
- 3. Do not touch, damage, or soil the pins.
- 4. Follow the recommended condition ratings about the power supply applied to this module.
- 5. Electrode peeling strength: Do not apply a force of more than 4.9 N in any direction on the soldered module.
- 6. Pressing on parts of the metal cover or fastening objects to the metal cover will cause damage.
- 7. These modules are intended for general purpose and standard use in general electronic equipment, such as home appliances, office equipment, information, and communication equipment.

5.4 Storage Notes

- 1. The module should not be stressed mechanically during storage.
- 2. Do not store these modules in the following conditions or the performance characteristics of the module, such as RF performance will be adversely affected:
 - Storage in salty air or in an environment with a high concentration of corrosive gas, such as Cl2, H2S, NH3, SO2, or NOX,
 - Storage in direct sunlight,
 - Storage in an environment where the temperature may be outside the range of 5 °C to 35 °C, or where the humidity may be outside the 45 % to 85 % range,
 - Storage of the modules for more than one year after the date of delivery storage period: Please check the adhesive strength of the embossed tape and soldering after 6 months of storage.
- 3. Keep this module away from water, poisonous gas, and corrosive gas.
- 4. This module should not be stressed or shocked when transported.
- Follow the specification when stacking packed crates (max. 10).

5.5 Safety Cautions

These specifications are intended to preserve the quality assurance of products and individual components.

Before use, check and evaluate the operation when mounted on your products. Abide by these specifications without deviation when using the products. These products may short-circuit. If electrical shocks, smoke, fire, and/or accidents involving human life are anticipated when a short circuit occurs, provide the following failsafe functions as a minimum:

PAN9028 Bluetooth Module 5 Cautions

- 1. Ensure the safety of the whole system by installing a protection circuit and a protection device
- 2. Ensure the safety of the whole system by installing a redundant circuit or another system to prevent a single fault causing an unsafe status.

5.6 Other Cautions

- Be sure to provide an appropriate fail-safe function on your product to prevent any additional damage that may be caused by the abnormal function or the failure of the module.
- 3. This module has been manufactured without any ozone chemical controlled under the Montreal Protocol.
- 4. These modules are not intended for use under the special conditions shown below. Before using these modules under such special conditions, carefully check their performance and reliability under the said special conditions to determine whether or not they can be used in such a manner:
 - In liquid, such as water, salt water, oil, alkali, or organic solvent, or in places where liquid may splash,
 - In direct sunlight, outdoors, or in a dusty environment,
 - In an environment where condensation occurs,
 - In an environment with a high concentration of harmful gas (e. g. salty air, HCl, Cl2, SO2, H2S, NH3, and NOX).
- 5. If an abnormal voltage is applied due to a problem occurring in other components or circuits, replace these modules with new modules, because they may not be able to provide normal performance even if their electronic characteristics and appearances appear satisfactory.



For further information please refer to the Panasonic website ⇒ 7.2.2 Product Information.

PAN9028 Bluetooth Module

5 Cautions

5.7 Restricted Use

5.7.1 Life Support Policy

This Panasonic Industrial Devices Europe GmbH product is not designed for use in life support appliances, devices, or systems where malfunction can reasonably be expected to result in a significant personal injury to the user, or as a critical component in any life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Panasonic customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Panasonic Industrial Devices Europe GmbH for any damages resulting.

5.7.2 Restricted End Use

This Panasonic Industrial Devices Europe GmbH product is not designed for any restricted activity that supports the development, production, handling usage, maintenance, storage, inventory or proliferation of any weapons or military use.

Transfer, export, re-export, usage or reselling of this product to any destination, end user or any end use prohibited by the European Union, United States or any other applicable law is strictly prohibited.



6 Regulatory and Certification Information

6.1 Federal Communications Commission (FCC) for US

6.1.1 FCC Notice



The PAN9028, including the ceramic antenna (ENWF9408A1EF and ENWF9408A2EF), and the antennas, which are listed in ⇒6.1.5 Approved Antenna List, complies with Part 15 of the FCC Rules.

The device meets the requirements for modular transmitter approval as detailed in FCC public Notice DA00-1407. This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- 1. This device may not cause harmful interference, and
- 2. This device must accept any interference received, including interference that may cause undesired operation.

The FCC identifier for ENWF9408A1EF is FCC ID: T7V-9028.

The FCC identifier for ENWF9408A2EF is FCC ID: T7V-9028.

6.1.2 Caution



The FCC requires the user to be notified that any changes or modifications made to this device that are not expressly approved by Panasonic Industrial Devices Europe GmbH may void the user's authority to operate the equipment.



This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules.

These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications.

There is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on.





It is recommended to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

6.1.3 Label Requirements



The OEM must ensure that FCC labelling requirements are met. This includes a clearly visible label (laser marking) on the outside of the OEM enclosure specifying the appropriate Panasonic FCC identifier for this product as well as the FCC Notice above.

The FCC identifier for model ENWF9408A1EF is FCC ID: T7V-9028.

The FCC identifier for model ENWF9408A2EF is FCC ID: T7V-9028.

This FCC identifier is valid for the PAN9028. The end product must in any case be labelled on the exterior with:

"Contains FCC ID: T7V-9028".

Due to the PAN9028 model size, the FCC identifier is displayed in the installation instruction only and it cannot be displayed readable on the module's label due to the limited size.

6.1.4 Antenna Warning

This antenna warning refers to the test device with the model number ENWF9408A1EF and ENWF9408A2EF in bottom pad mode ⇒ RF-Switch Pin Function.

The device is tested with a standard SMA connector and with the antenna listed below. When integrated into the OEM's product, these fixed antennas require installation preventing end users from replacing them with non-approved antennas. Any antenna not in the following table must be tested to comply with FCC Section 15.203 for unique antenna connectors and with Section 15.247 for emissions. The FCC identifier for the device with the antenna listed in

⇒ 6.1.5 Approved Antenna List is the same (FCC ID: T7V-9028).



6.1.5 Approved Antenna List

Item	Part Number	Manufacturer	Туре	Polarization	Frequency Band	Gain (dBi)
	ANT162442DT-	TDK	Chip	Linear	2.400 - 2.484 GHz	2.1
	2001A2		Antenna		5.150 - 5.850 GHz	1.5

6.1.6 RF Exposure



To comply with FCC RF Exposure requirements, the OEM must ensure that only antennas from the Approved Antenna List are installed ⇒ 6.1.5 Approved Antenna List.

The preceding statement must be included as a caution statement in manuals for products operating with the approved antennas in the previous table to alert users on FCC RF Exposure compliance.

Any notification to the end user of installation or removal instructions about the integrated radio module is not allowed.

The radiated output power of the PAN9028 with a mounted ceramic chip antenna (FCC ID: T7V-9028 for model ENWF9408A1EF and ENWF9408A2EF) are fulfilled for mobile configuration. The installation of the module is restricted to mobile host devices. The PAN9028 shall be used in such a manner that the potential for human contact during normal operation is minimized.

End users may not be provided with the module installation instructions. OEM integrators and end users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

6.1.7 Integration Instructions

This chapter gives integration instructions for host product manufacturers according to KDB 996369 D03 OEM Manual v01.

Section	Topic and Comment					
2.2	List of applicable FCC rules					
	47 CFR Section	Part 15C				
	Frequency Band (MHz)	2 400 to 2 483.5				
	Systems	Digital Transmission Systems operating within the 2 400 - 2 483.5 MHz Band				
	Reference / Requirement	15.247(a)(2), 15.247(b)(1), 15.207, 15.247(d), 15.247(e)				
	Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF				



	47 CFR Section	Part 15C				
	Frequency Band (MHz)	2 400 to 2 483.5				
	Systems	Frequency Hopping Systems operating within the 2 400 - 2 483.5 MHz Band				
	Reference / Requirement	15.247(a)(1), 15.247(a)(1)(iii), 15.247(b)(1), 15.207, 15.247(d)				
	Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF				
	47.050.0.0	D				
	47 CFR Section	Part 15E				
	Systems	Unlicensed National Information Infrastructure Devices in the 5 GHz Bands				
	Reference Method	KDB 905462 D02 v02				
	Reference / Requirement	15E.407(h)(2)				
	Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF				
2.3	Summarize the specific	c operational use conditions				
	Please refer to sections ⇒ List.	5 Cautions, 5.3 Usage Condition Notes, and 6.1.5 Approved Antenna				
2.4	Limited module procedures					
	Not applicable, the module has a single-modular transmitter approval.					
2.5	Trace antenna designs					
	Not applicable, the module has a ceramic chip antenna. For guidance regarding the PCB layout requirements for module integration refer to the Design Guide ⇒ 7.2.2 Product Information.					
2.6	RF exposure considerations					
	Mobile application, the end 20 cm from the human bod	customer has to assure that the device has a distance of more than y under all circumstances.				
2.7	Antennas					
	Please refer to sections ⇒	6.1.4 Antenna Warning and 6.1.5 Approved Antenna List.				
2.8	Label and compliance	information				
	Please refer to section ⇒ 6	.1.3 Label Requirements.				
2.9	Information on test mo	des and additional testing requirements				
	The documents for integrat Product Information.	ion guidance and compliance testing are available here ⇒ 7.2.2				
2.10	Additional testing, Part	t 15 Subpart B disclaimer				
	The single-modular transmitter is FCC authorized for the specific rule parts listed at section ⇒ List of applicable FCC rules.					
	The host product manufacturer needs to also consider the FCC requirements for certified modular transmitter being used in the host product and maintain documentation on how the host product with the certified modular transmitter complies with the FCC rules. Host product manufacturers are responsible to follow the integration guidance and to perform a limited set of transmitter module verification testing, to ensure the end product is in compliance with the FCC rules. Also host product manufacturers are responsible for all additional equipment authorization and testing for technical requirements not covered by the module grant (e.g., unintentional radiator Part 15 Subpart B requirements, or transmitters used in the host that are not certified modules).					



6.2 Innovation, Science, and Economic Development (ISED) for Canada

English

PAN9028 and versions are licensed to meet the regulatory requirements of ISED.

License for M/N: ENWF9408A1EF: IC: 216Q-9028
License for M/N: ENWF9408A2EF: IC: 216Q-9028

Manufacturers of mobile, fixed, or portable devices incorporating this module are advised to clarify any regulatory questions and ensure compliance for SAR and/or RF exposure limits. Users can obtain Canadian information on RF exposure and compliance from www.ic.gc.ca.

This device has been designed to operate with the antennas listed in \Rightarrow 6.1.5 Approved Antenna List, having a maximum gain of 2.1 dBi for 2.4 GHz and 1.5 dBi for 5 GHz. Antennas not included in this list or having a gain greater than 2.1 dBi for 2.4 GHz and 1.5 dBi for 5 GHz are strictly prohibited for use with this device. The required antenna impedance is 50 Ω . The antenna used for this transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

French

PAN9028 (et ses versions) est garanti conforme aux dispositions règlementaires d'Innovation, Sciences et Développement économique (ISDE).

Licence pour M/N: ENWF9408A1EF: IC: 216Q-9028
Licence pour M/N: ENWF9408A2EF: IC: 216Q-9028

Il est recommandé aux fabricants d'appareils fixes, mobiles ou portables de consulter la réglementation en vigueur et de vérifier la conformité de leurs produits relativement aux limites d'exposition aux rayonnements radiofréquence ainsi qu'au débit d'absorption spécifique maximum autorisé.

Des informations pour les utilisateurs sur la réglementation Canadienne concernant l'exposition aux rayonnements RF sont disponibles sur le site www.ic.gc.ca.

Ce produit a été développé pour fonctionner spécifiquement avec les antennes listées dans le tableau \Rightarrow 6.1.5 Approved Antenna List, présentant un gain maximum de 2.1 dBi pour 2.4 GHz et 1.5 dBi pour 5 GHz. Des antennes autres que celles listées ici, ou présentant un gain supérieur à 2.1 dBi pour 2.4 GHz et 1.5 dBi pour 5 GHz ne doivent en aucune circonstance être utilises en combinaison avec ce produit. L'impédance des antennes compatibles est 50 Ω . L'antenne utilisée avec ce produit ne doit ni être située à proximité d'une autre antenne ou d'un autre émetteur, ni être utilisée conjointement avec une autre antenne ou un autre émetteur.

6.2.1 Radio Standards Specification RSS-247 Issue 2

The Radio Standards Specification RSS-247, Issue 2, Digital Transmission Systems (DTSs), Frequency Hopping Systems (FHSs) and License-Exempt Local Area Network (LE-LAN) Devices, replaces RSS-247, Issue 1, dated May 2015. It sets out certification requirements for radio apparatus operating in the bands 2 400 MHz to 2 483.5 MHz and 5 725 MHz to 5 850 MHz employing frequency hopping, digital modulation and/or a combination (hybrid) of both



techniques. It also includes license exempt local area network (LE-LAN) devices operating in the bands 5 150 MHz to 5 250 MHz, 5 250 MHz to 5 350 MHz, 5 470 MHz to 5 725 MHz and 5 725 MHz to 5 850 MHz as specified in SP-5 150 MHz.

6.2.1.1 General

Equipment covered by the standard RSS-247 is classified as Category I equipment. Either a technical acceptance certificate (TAC) issued by the Certification and Engineering Bureau of Innovation, Science and Economic Development Canada (ISED) or a certificate issued by a certification body (CB) is required.

6.2.1.2 Certification Requirements

RSS-247 shall be used in conjunction with RSS-Gen, General Requirements for Compliance of Radio Apparatus, for general specifications and information relevant to the equipment for which this standard applies. Equipment certified under the standard is required to comply with the provisions in RSS-Gen with respect to emissions falling within restricted frequency bands. These restricted frequency bands are listed in RSS-Gen.

6.2.1.3 Measurement Method

In addition to the requirements in RSS-Gen and the requirements of the standard RSS-247, the method for measuring DTS devices is provided in ANSI C63.10.

6.2.1.4 FHS and DTS operating in the bands 2 400 MHz to 2 483.5 MHz

This section applies to frequency hopping systems (FHSs) in the bands 2 400 MHz to 2 483.5 MHz and 5 725 MHz to 5 850 MHz and digital transmission systems (DTSs) in the band 2 400 MHz to 2 483.5 MHz. Systems in these bands can be frequency hopping, digital transmission and/or a combination (hybrid) of both types. The digital transmission technology of DTSs or hybrid systems operating in the band 5 725 MHz to 5 850 MHz shall comply with the requirement in section Technical requirements for license-exempt local area network devices and digital transmission systems operating in the 5 GHz band.





RSS-247 Section	5.1
Frequency Band (MHz)	2 400 to 2 483.5
Systems	Frequency Hopping Systems
Systems out of Scope	FHS operating in the band 5 725 MHz to 5 850 MHz Fixed point-to-point systems
Requirements	The maximum peak conducted output power shall not exceed W if the hopset uses 75 or more hopping channels; the maximum peak conducted output power shall not exceed 0.125 W if the hopset uses less than 75 hopping channels.
Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF

RSS-247 Section	5.2
Frequency Band (MHz)	2 400 to 2 483.5
Systems	Digital Transmission Systems
Systems out of Scope	-
Requirements	The minimum 6 dB bandwidth shall be 500 kHz.
	The transmitter power spectral density conducted from the transmitter to the antenna shall not be greater than 8 dBm in any 3 kHz band during any time interval of continuous transmission.
	The maximum peak conducted output power shall not exceed 1 W. The e.i.r.p. shall not exceed 4 W.
Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF

RSS-247 Section	5.3
Frequency Band (MHz)	2 400 to 2 483.5
Systems	Hybrid Systems
Systems out of Scope	Hybrid devices operating in the band 5 725 MHz to 5 850 MHz.
Requirements	With the digital transmission operation of the hybrid system turned off, the frequency hopping operation shall have an average time of occupancy on any frequency not exceeding 0.4 seconds within a duration in seconds equal to the number of hopping frequencies multiplied by 0.4. With the frequency hopping turned off, the digital transmission operation shall comply with the power spectral density requirements for digital modulation systems set out in section "5.2" ⇒ RSS-247 Section.
Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF



RSS-247 Section	5.4
Frequency Band (MHz)	2 400 to 2 483.5
Systems	FHSs operating in the band 2 400 to 2 483.5 MHz.
	DTSs employing digital modulation techniques operating in the band 2 400 MHz to 2 483.5 MHz.
Systems out of Scope	FHSs operating in the band 902 MHz to 928 MHz and 5 725 MHz to 5 850 MHz.
	DTSs employing digital modulation techniques operating in the bands 902 MHz to 928 MHz.
	Fixed point-to-point systems in the bands 2 400 MHz to 2 483.5 MHz and 5 725 MHz to 5 850 MHz.
	Transmitters operating in the band 2 400 MHz to 2 483.5 MHz, may employ antenna systems that emit multiple directional beams simultaneously or sequentially.
Requirements	Transmitter Output Power:
	The maximum peak conducted output power shall not exceed 1 W if the hopset uses 75 or more hopping channels; the maximum peak conducted output power shall not exceed 0.125 W if the hopset uses less than 75 hopping channels. The e.i.r.p. shall not exceed 4 W.
	For DTSs employing digital modulation techniques operating in the band 2 400 MHz to 2 483.5 MHz, the maximum peak conducted output power shall not exceed W. The e.i.r.p. shall not exceed 4 W.
Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF

RSS-247 Section	5.5			
Frequency Band (MHz)	2 400 to 2 483.5			
System	In any 100 kHz bandwidth outside the frequency band in which the spread spectrum or digitally modulated device is operating			
System out of Scope	-			
Requirements	Unwanted Emissions:			
	In any 100 kHz bandwidth outside the frequency band in which the spread spectrum or digitally modulated device is operating, the RF power that is produced shall be at least 20 dB below that in the 100 kHz bandwidth within the band that contains the highest level of the desired power, based on either an RF conducted or a radiated measurement, provided that the transmitter demonstrates compliance with the peak conducted power limits. If the transmitter complies with the conducted power limits based on the use of root-mean-square averaging over a time interval the attenuation required shall be 30 dB instead of 20 dB. Attenuation below the general field strength limits specified in RSS-Gen is not required.			
Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF			



6.2.1.5 Requirements for LE-LAN and DTS operating in the 5 GHz Band

The section provides standards for Licence-Exempt Local Area Network (LE-LAN) devices operating in the bands:

- 5 150 to 5 250 MHz,
- 5 725 to 5 850 MHz
- For DTSs operating in the band 5 725 MHz to 5 850 MHz that employ digital modulation technology, but are not designed for LE-LAN operation.

Devices with occupied bandwidths which overlap different bands shall comply with all operational requirements for each band.

RSS-247 Section	6.2.1			
Frequency Band (MHz)	5 150 to 5 250			
Device Type	LE-LAN devices are restricted to indoor operation only.			
Devices out of Scope	OEM devices installed in vehicles.			
Power Limits	Maximum e.i.r.p. shall not exceed 200 mW or 10+10 log10B, dBm, whichever power is less. B is the 99 % emission bandwidth in megahertz. The e.i.r.p. spectral density shall not exceed 10 dBm in any 1 MHz band.			
Unwanted Emission Limits	For transmitters with operating frequencies in the band 5 150 MHz to 5 250 MHz, all emissions outside the band 5 150 MHz to 5 350 MHz shall not exceed -27 dBm/MHz e.i.r.p. Any unwanted emissions that fall into the band 5 250 MHz to 5 350 MHz shall be attenuated below the channel power by at least 26 dB, when measured using a resolution bandwidth between 1 % and 5 % of the occupied bandwidth (i.e. 99% bandwidth), above 5 250 MHz. The 26 dB bandwidth may fall into the 5 250 MHz to 5 350 MHz band; if the occupied bandwidth also falls within the 5 250 MHz to 5 350 MHz band, the transmission is considered as intentional and the devices shall comply with all requirements in the band 5 250 MHz to 5 350 MHz including implementing dynamic frequency selection (DFS) and TPC, on the portion of the emission that resides in the 5 250 MHz to 5 350 MHz band.			
Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF			

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RSS-247 Section	6.2.4			
Frequency Band (MHz)	5 725 to 5 850			
Device Type	For equipment operating in the band 5 725 MHz to 5 850 MHz			
Devices out of Scope	Fixed point-to-point devices and devices with antenna gain greater than 6 dBi.			
Power Limits	The minimum 6 dB bandwidth shall be at least 500 kHz. The maximum conducted output power shall not exceed 1 W. The output power spectral density shall not exceed 30 dBm in any 500 kHz band.			
Unwanted Emission Limits	Devices shall have e.i.r.p. of unwanted emissions comply with the following:			
	27 dBm/MHz at frequencies from the band edges decreasing linearly to 15.6 dBm/MHz at 5 MHz above or below the band edges			
	15.6 dBm/MHz at 5 MHz above or below the band edges decreasing linearly to 10 dBm/MHz at 25 MHz above or below the band edges			
	10 dBm/MHz at 25 MHz above or below the band edges decreasing linearly to -27 dBm/MHz at 75 MHz above or below the band edges			
	-27 dBm/MHz at frequencies more than 75 MHz above or below the band edges			
Complied Module M/N	ENWF9408A1EF, ENWF9408A2EF			



6.2.2 IC Notice

English



The device PAN9028 and versions (⇒ 7.1 Ordering Information), including the antennas (⇒ 6.1.5 Approved Antenna List), comply with Canada RSS-Gen Rules. The device meets the requirements for modular transmitter approval as detailed in RSS-Gen.

Operation is subject to the following two conditions:

- 1. This device may not cause harmful interference, and
- 2. This device must accept any inference received, including interference that may cause undesired operation.

French



Le présent appareil PAN9028 (⇒ 7.1 Ordering Information), les antennes y compris (⇒ 6.1.5 Approved Antenna List), est conforme aux CNR-Gen d'ISDE applicables aux appareils radio exempts de licence.

L'exploitation est autorisée aux deux conditions suivantes:

- 1. L'appareil ne doit pas produire de brouillage, et
- 2. L'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.



6.2.3 Labeling Requirements

English



Labeling Requirements

The OEM must ensure that IC labelling requirements are met. This includes a clearly visible label on the outside of the OEM enclosure specifying the appropriate Panasonic IC identifier for this product as well as the IC Notice above.

The IC identifiers are:

IC: 216Q-9028 (for M/N: ENWF9408A1EF)

IC: 216Q-9028 (for M/N: ENWF9408A2EF)

These IC identifiers are valid for all PAN9028 modules ⇒ 7.1 Ordering Information. In any case, the end product must be labelled on the exterior with:

"Contains IC: 216Q-9028".

French



Obligations d'étiquetage

Les fabricants d'équipements d'origine (FEO) – en anglais Original Equipment Manufacturer (OEM) – doivent s'assurer que les obligations d'étiquetage IC du produit final sont remplies. Ces obligations incluent une étiquette clairement visible à l'extérieur de l'emballage externe, comportant l'identifiant IC du module Panasonic inclus, ainsi que la notification ci-dessus.

L' identifiant IC est:

IC: 216Q-9028 (pour M/N: ENWF9408A1EF)

IC: 216Q-9028 (pour M/N: ENWF9408A2EF)

Cet identifiant est valide pour tous les modules PAN9028 ⇒ 7.1 Ordering Information. Dans tous les cas les produits finaux doivent indiquer sur leur emballage externe la mention suivante:

"Contient IC: 216Q-9028".



6.3 European Conformity According to RED (2014/53/EU)

The PAN9028 modules with model number ENWF9408A1EF and ENWF9408A2EF comply with the standards according to the following LVD (2014/35/EU), EMC-D (2014/30/EU) together with RED (2014/53/EU) articles:

3.1a Safety/Health: EN 62368-1:2014

EN 62311:2008

3.1b EMC: EN 301 489-1 V2.2.3

EN 301 489-3 V2.1.2 (Draft)

EN 301 489-17 V3.2.4

3.2 Radio: EN 300 328 V2.2.2

EN 301 893 V2.1.1 EN 300 440 V2.1.1

- Due to the model size, the CE marking is displayed in the installation instruction only andit cannot be displayed conform to regulation (EU) No 765/2008 in 5mm height on the module's label due to the limited space.
- The RED EU Type Examination Certificate No. G0M-2010-9377-V01 issued by the Notified Body 0608 can be used for the OEM end product conformity assessment. If a Notified Body has been contracted for the end product conformity assessment, it should be noted that this EU Type Examination Certificate should be used for conformance assessment.

As a result of the conformity assessment procedure described in 2014/53/EU Directive, the end customer equipment should be labelled as follows:





The end customer has to assure that the device has a distance of more than 20 cm from the human body under all circumstances.

The end customer equipment must meet the actual Safety/Health requirements according to RED.

PAN9028 and its model versions in the specified reference design can be used in all countries of the European Economic Area (Member States of the EU, European Free Trade Association States [Iceland, Liechtenstein, and Norway]), Monaco, San Marino, Andorra, and Turkey.



6.3.1 Radio Equipment Directive

The Radio Equipment Directive 2014/53/EU (RED) establishes a regulatory framework for placing radio equipment on the market. It ensures a Single Market for radio equipment by setting essential requirements for safety and health, electromagnetic compatibility, and the efficient use of the radio spectrum.

The RED aligned the previous Directive, the Radio and Telecommunication Terminal Equipment Directive 1999/5/EC (R&TTED), with the new legislative framework for the marketing of products. The RED is applicable as of 2016-06-13. It included a one-year transitional period, which ended on 2017-06-12 (Article 48). On 2017-06-20, the Commission Implementing Regulation (EU) 2017/1354 was adopted. This specifies how to present the information provided for in Article 10(10) of Directive 2014/53/EU.

Article 10(10) RED

In cases of restrictions on putting into service or of requirements for authorisation of use, information available on the packaging shall allow the identification of the Member States or the geographical area within a Member State where restrictions on putting into service or requirements for authorisation of use exist. Such information shall be completed in the instructions accompanying the radio equipment. The Commission may adopt implementing acts specifying how to present that information. Those implementing acts shall be adopted in accordance with the advisory procedure referred to in Article 45(2).

Class 1:

Radio equipment that can be operated without any restriction in EU, EEA, and EFTA. According to Article 8(1)b of the RED, it is clarified that no national radio interfaces specifications are required to be notified under RED;

Class 2:

Radio equipment subject to restrictions in one or more EU, EEA and EFTA countries where:

- The technical parameters are not harmonised through EU, EEA, and EFTA;
- The technical parameters are harmonised through EU, EEA and EFTA, and do not fall in above class 1 definition.

Radio equipment class means a class identifying particular categories of radio equipment which, under this Directive, are considered similar and those radio interfaces for which the radio equipment is designed.

Article 8 RED

Notification of radio interface specifications and assignment of radio equipment classes 1:

- 1) Member States shall notify, in accordance with the procedure set out in Directive 98/34/EC, the radio interfaces which they intend to regulate except:
 - a) The radio interfaces which fully and without any deviation comply with the Commission decisions on the harmonised use of radio spectrum adopted pursuant to Decision No. 676/2002/EC; and



- b) The radio interfaces which, in accordance with implementing acts adopted pursuant to paragraph 2 of this Article, correspond to radio equipment which can be put into service and used without restrictions within the Union.
- 2) The Commission shall adopt implementing acts establishing the equivalence between notified radio interfaces and assigning a radio equipment class, details of which shall be published in the Official Journal of the European Union. Those implementing acts shall be adopted in accordance with the examination procedure referred to in Article 45(3).

The Radio Interface Specifications Templates are provided for information in the EFIS database for applications which use is in harmonised radio spectrum, however with restrictions.

6.3.2 Equipment Classes

The PAN9028 is a radio module classified as class-1 or class-2 radio equipment depending on the frequency band in which it can operate. This equipment class is passed on the end-product which integrates the module.

Class 1

Class 1 radio equipment can be placed on the market and put into service without restrictions according to Article 1(3) of Commission Decision 2000/299/EC (Version 2018-01).

This radio module is defined as Class 1 radio equipment when it is restricted to operate in the following frequency bands:

Sub-class of Class 1	Application/Reference	Frequency Band (MHz)	Transmit Power/Power Density
22	Wideband Data Transmission Systems EN 300 328	2 400 to 2 483.5	100 mW e.i.r.p and 100 mW/100 kHz e.i.r.p. density applies when frequency hopping modulation is used, 10 mW/MHz e.i.r.p. density applies when other types of modulation are used.
43	Non-Specific Short Range Devices EN 300 440	5 725 to 5 875	25 mW e.i.r.p.

Class 2

Class 2 radio equipment are restricted in accordance with Article 1(3) of Commission Decision 2000/299/EC1 if the equipment falls within the scope of Class 2.

This radio module is also defined as Class 2 radio equipment when it is restricted to operate in the following frequency bands:

6 Regulatory and Certif

Sub-class of Class 2	Application/Reference	Frequency Band (MHz)	Transmit Power/Power Density
H01	Wireless Access Systems including Radio Local Area Networks (WAS/RLANs) Restricted to indoor use	5 150 to 5 350	Max. 200 mW mean e.i.r.p. and max. 10 mW/MHz mean e.i.r.p. density in any 1 MHz band.
	EN 301 893		



The usage of PAN9028 module in a vehicular environment cannot be considered as **indoor use**.



6.4 Bluetooth Qualification

The PAN9028 series modules are Bluetooth qualified as "Controller Subsystem". Following the qualified design ID's listed for the module:

Bluetooth Product	Project Name	Power Class	Model	Declaration ID	QDID
Controller Subsystem	PAN9028	1	ENWF940xAxEF	D052581	172842

If the module is combined with a host stack that is Bluetooth qualified as "Host Subsystem" it is possible to list an "End Product" without any further qualification tests.



The OpenSynergy Bluetooth software is commercially available and is delivered in source code format. Applications that are built using the Blue SDK are executed in Linux user space making development easy. The stack software and profiles are qualified components and are listed on the Bluetooth SIG website.

- Blue SDK v6.x and Low Energy SDK v3.x: QDID 120439
- Bluetooth traditional profiles: QDID 117748

Bluetooth Marks

According to the Bluetooth SIG, the PAN9028 fulfills the criteria to label your product as a Bluetooth device:



For further information please refer to the Bluetooth website www.bluetooth.com.

6.5 RoHS And REACH Declaration

The latest declaration of environmental compatibility (RoHS and REACH) for supplied products can be found on the Panasonic website in the "Downloads" section of the respective product ⇒ 7.2.2 Product Information.

PAN9028 Bluetooth Module 7 Appendix

7 Appendix

7.1 Ordering Information

Variants and Versions

Order Number	Brand Name	Description	MOQ ¹⁵
ENWF9408A1EF ¹⁶	PAN9028	Wi-Fi/Bluetooth radio module IEEE 802.11 a/b/g/n/ac Bluetooth/Bluetooth LE 5 with a ceramic chip-antenna, Multi-region version certified for US, EU, and CA ¹⁷	500
ENWF9408A2EF ¹⁶	PAN9028	Wi-Fi/Bluetooth radio module IEEE 802.11 a/b/g/n/ac Bluetooth/Bluetooth LE 5 with a ceramic chip-antenna, without PMIC 88PG823, Multi-region version certified for US, EU, and CA ¹⁷	500
ENWF9408AXEF	PAN9028-IMX	i.MX6+PAN9028 Development Kit:	1
		1× PAN9028 MicroSD Adapter,	
		1× Wandboard WBIMX6U,	
		1× MicroSD Card,	
		1x Adapter cable USB-A to DC 5.5/2.5mm plug	
ENWF9408AZEF	PAN9028-IMX2	i.MX6+PAN9028 Development Kit:	1
		1x PAN9028 MicroSD Adapter,	
		1x Wandboard WBIMX6U,	
		1× MicroSD-UART Card,	
		1x Adapter cable USB-A to DC 5.5/2.5mm plug	
ENWF9408AWEF	PAN9028-MSD	PAN9028 MicroSD Adapter with module ENWF9408A1EF	1
ENWF9408AVEF	PAN9028-MSDU	PAN9028 MicroSD-UART Adapter with module ENWF9408A1EF	1

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¹⁵ Abbreviation for Minimum Order Quantity (MOQ). The default MOQ for mass production is 1000 pieces, fewer only on customer demand. Samples for evaluation can be delivered at any quantity via the distribution channels.

¹⁶ Samples are available on customer demand.

¹⁷ The multi-region version is restricted to FCC, European ETSI, and Canadian ISED regulatory domain with blocked Tx power table, which is stored on the OTP memory of device. The device does not support the channels 12 to13 in the 2.4 GHz band. DFS and passive scanning mechanism are not necessary as only the non-DFS channels in the 5 GHz band are supported.



7.2 Contact Details

7.2.1 Contact Us

Please contact your local Panasonic Sales office for details on additional product options and services:

For Panasonic Sales assistance in the EU, visit

https://eu.industrial.panasonic.com/about-us/contact-us

Email: wireless@eu.panasonic.com

For Panasonic Sales assistance in **North America**, visit the Panasonic website "Sales & Support" to find assistance near you at

https://na.industrial.panasonic.com/distributors

Please visit the **Panasonic Wireless Technical Forum** to submit a question at https://forum.na.industrial.panasonic.com

7.2.2 Product Information

Please refer to the Panasonic Wireless Connectivity website for further information on our products and related documents:

For complete Panasonic product details in the EU, visit

http://pideu.panasonic.de/products/wireless-modules.html

For complete Panasonic product details in North America, visit

http://www.panasonic.com/rfmodules

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Click to view similar products for WiFi Modules - 802.11 category:

Click to view products by Panasonic manufacturer:

Other Similar products are found below:

WIFI-RT5392-SB-R10 SX-PCEAN2C-SP 849WM520100E WIFI-AT2350 7265.NGWG.SW HDG204-DN-3 FXX-3061-MIX EMIO-1533-00A2 PPC-WL-KIT02-R11 RC-CC2640-B HLK-7688A E70-433T14S WH-NB73-BA NF-02-PA EAR00364 ATSAMW25H18-MR210PB1961 3168.NGWG MY-WF003U AX210.NGWG.NV ESP-15F32Mbit ESP32-S32Mb TG-01M ESP-13 ESP-01F-2M ESP-01E-2M ESP-12S-8285-2M ESP-20 ESP32-SL ESP-12K-PSRAM ESP-12K ESP-12K-PSRAM-IPEX ESP-12H BW18 BW12-16Mb BW14 BW15 BW16 TG-12F SIM7600CE-L1S CB3S(tjrl) CB3S(hvk9) CB3S(qh6) WB2S(csyd) WB3S(ppty) WB3S(h238) WB3S(uvmz) 1005869 1012 QCA4004X-BL3B 32-2006-BU